



Cortina Systems® LXT9883/LXT9863 Advanced 10/100 Unmanaged Repeater

Datasheet: Long Form

The LXT9883 is an advanced, 3.3V, 8-port 10/100 repeater. The LXT9883 Repeater is compatible with previous generations of repeaters from the LXT980 and LXT918 families. Eight ports directly support 100BASE-TX/10BASE-T copper media. Two additional Media Independent Interface (MII) ports (10/100 Mbps selectable) connect to Media Access Controllers (MACs) for bridge/switch applications. The LXT9863 Repeater offers the same features and functionality in a six-port device. This data sheet uses the singular designation "LXT98x3 Repeater" to refer to both devices.

The LXT98x3 Repeater provides auto-negotiation with parallel detection for the PHY ports. The LXT98x3 Repeater provides two internal repeater state machines—one operating at 10 Mbps and one at 100 Mbps. Once configured, the LXT98x3 Repeater automatically connects each port to the appropriate repeater. The LXT98x3 Repeater also provides two Inter-Repeater Backplanes (IRBs) for expansion — one operating at 10 Mbps and one at 100 Mbps. Up to 240 twisted-pair and MII ports can logically be combined into one repeater.

Product Features

- Six or eight 10/100 ports with integrated twisted-pair PHYs including integrated filters.
 - Two 10/100 MIIs for bridging.
 - Independent segments for 10Mbps and 100 Mbps operation.
 - Cascadable Inter-Repeater Backplanes (IRBs), with option for 5V stacking compatibility.
 - Integrated LED drivers with user-selectable modes.
 - Available in 208-pin QFP package.
 - Operating temperature range: 0-70°C, ambient.
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Revision History

Revision 5.0 Revision Date: 03 October 2007
First release of this document from Cortina Systems, Inc. <ul style="list-style-type: none"> Removed ordering and marking Information. This information is now available from www.cortina-systems.com.
Revision 004 Revision Date: 11 April 2006
<ul style="list-style-type: none"> Added Section 6.1, <i>Top Label Markings</i>, on page 56
Revision 003 Revision Date: 01 August 2001
<ul style="list-style-type: none"> Modify the Absolute Maximum Ratings Supply Voltage value to 4.0V.

Revision 002 Revision Date: 01 February 2001

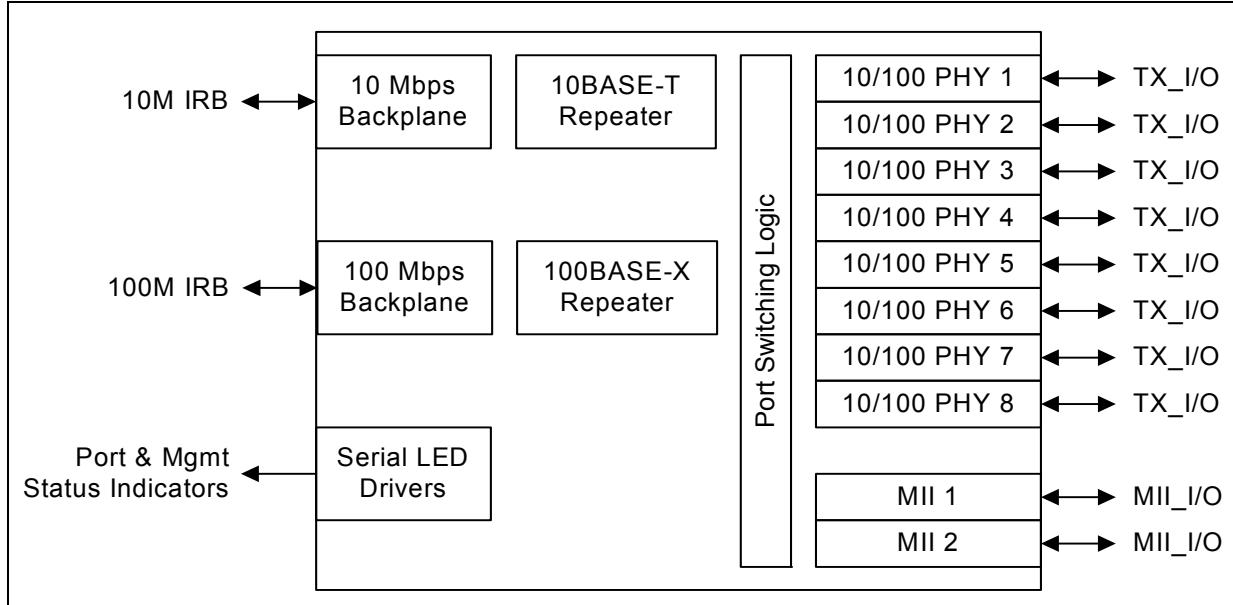
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| <ul style="list-style-type: none">• Modified clock requirements language.• Replaced TBD value under reset to 3.15 V.• Replaced TBDs in fourth para under Supply Filtering to 1000 mA and 1500 mA.• Replaced TBDs in fourth bullet under Twisted-Pair Interface to 1000 mA and 1500 mA.• Modified Oscillator Manufacturers table• Typical 100 Mbps IRB Implementation table:
Modified note 2 (replaced "FPS/ = 0" with "FPS/ ≠ 0.")• Typical 10 Mbps IRB Implementation table:
Modified note 2 (replaced "FPS/ = 0" with "FPS/ ≠ 0.")• Absolute Maximum Ratings table:
Replaced TBD for Supply Voltage under Max to 3.45.
Deleted Operating Temperature lines and values.• Operating Conditions table:
For Power Consumption: removed Auto-Negotiation values.
Changed description and values for 8- and 6-port active. |
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Revision 001 Revision Date: 01 January 2001
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| <ul style="list-style-type: none">• Initial Draft |
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1.0 Block Diagram

Figure 1 LXT98x3 Repeater Block Diagram



2.0 Pin Assignments and Signal Descriptions

Figure 2 LXT9883 Repeater Pin Assignments

52	N/C	208	MI12_RXD3
51	N/C	207	MI12_RXD2
50	IR100CLK	206	MI12_RXD1
49	IR100DAT4	205	MI12_RXD0
48	IR100DAT3	204	MI12_RXDV
47	VCC	203	MI12_RXCLK
46	GND	202	MI12_RXER
45	IR100DAT2	201	N/C
44	IR100DAT1	200	VCC
43	IR100DAT0	199	GND
42	IR100DV	198	N/C
41	IR100DEN	197	MI12_TXER
40	IR100COL	196	MI12_TXCLK
39	COMP SEL	195	MI12_TXEN
38	IR100SNGT	194	MI12_TXD0
37	IR100CFBFP	193	MI12_TXD1
36	IR100CFB	192	MI12_TXD2
35	MI11_RXD3	191	MI12_TXD3
34	MI11_RXD2	190	VCC
33	N/C	189	GND
32	MI11_RXD1	188	MI12_COL
31	MI11_RXD0	187	MI12_CRS
30	MI11_RXDV	186	COL100_LED
29	MI11_RXCLK	185	LEDSEL1/COL10_LED
28	VCC	184	LEDSEL0/ACT100_LED
27	GND	183	AUTOBLINK/ACT10_LED
26	MI11_RXER	182	N/C
25	N/C	181	GND
24	MI11_TXER	180	VCC
23	MI11_TXCLK	179	GND
22	MI11_TXEN	178	N/C
21	MI11_TXD0	177	VCC
20	MI11_TXD1	176	PORT8_LED1*
19	MI11_TXD2	175	PORT8_LED2*/LEDABGSEL
18	MI12_SPD	174	PORT8_LED3*
17	MI11_TXD3	173	VCC
16	VCC	172	GND
15	GND	171	PORT7_LED1*
14	MI11_COL	170	PORT7_LED2*
13	MI11_CRS	169	PORT7_LED3*
12	IR100CLK	168	GND
11	IR100DAT	167	PORT6_LED1
10	IR100ENA	166	PORT6_LED2
9	MI11_SPD	165	PORT6_LED3
8	VCC	164	GND
7	GND	163	PORT5_LED1
6	IR100DEN	162	PORT5_LED2
5	IR100CFBFP	161	PORT5_LED3
4	IR100COLBP	160	TxSLEW_1
3	IR100COL	159	TxSLEW_0
2	IR100CFB	158	GND
1	GND	157	*TPIP8
105	TPIN1		
106	VCCR		
107	TPOP1		
108	TPON1		
109	GND		
110	TPON2		
111	TPOP2		
112	VCCR		
113	VCCR		
114	TPIN2		
115	TPIP2		
116	GND		
117	GND		
118	TPIP3		
119	TPIN3		
120	VCCR		
121	TPOP3		
122	TPON3		
123	GND		
124	TPON4		
125	VCCR		
126	VCCR		
127	VCCR		
128	TPIN4		
129	TPIP4		
130	GND		
131	GND		
132	TPIP5		
133	TPIN5		
134	VCCR		
135	VCCR		
136	TPOP5		
137	TPON5		
138	GND		
139	TPON6		
140	TPOP6		
141	VCCR		
142	TPIN6		
143	TPIP6		
144	GND		
145	GND		
146	*TPIP7		
147	*TPIN7		
148	VCCR		
149	VCCR		
150	*TPOP7		
151	*TPON7		
152	GND		
153	*TPON8		
154	*TPOP8		
155	VCCR		
156	*TPIN8		

* Indicates LXT9883-only pins. TP Ports 7 and 8 are not available on LXT9863

Package Topside Markings

Marking	Definition
Part #	LXT9883 Repeater is the unique identifier for this product family.
Rev #	Identifies the particular silicon "stepping" (Refer to Specification Update for additional stepping information.)

Table 1 MII #1 Signal Descriptions

Pin	Symbol	Type ^{1, 2}	Description
9	MII1_SPD	I PU	Speed Select - MII 1. This signal is sensed at power up, hardware reset, and software reset. Selects operating speed of the respective MII (MAC) interface. High = 100 Mbps. Low = 10 Mbps.
31 32 34 35	MII1_RXD0 MII1_RXD1 MII1_RXD2 MII1_RXD3	O	Receive Data - MII 1. The LXT98x3 Repeater transmits received data to the controller on these outputs. Data is driven on the falling edge of MII1_RXCLK.
30	MII1_RXDV	O	Receive Data Valid - MII 1. Active High signal, synchronous to MII1_RXCLK, indicates valid data on MII1_RXD<3:0>.
29	MII1_RXCLK	O	Receive Clock - MII 1. MII receive clock for expansion port. This is a 2.5 or 25 MHz clock derived from the CLK25 input (refer to Table 7 on page 17).
26	MII1_RXER	O	Receive Error - MII 1. Active High signal, synchronous to MII1_RXCLK, indicates invalid data on MII1_RXD<3:0>.
24	MII1_TXER	I	Transmit Error - MII 1. MII1_TXER is a 100M-only signal. The MAC asserts this input when an error has occurred in the transmit data stream. The LXT98x3 Repeater responds by sending 'Invalid Code Symbols' on the line.
23	MII1_TXCLK	O	Transmit Clock - MII 1. This is a 2.5 or 25 MHz clock derived from the CLK25 input (refer to Table 7 on page 17).
22	MII1_TXEN	I	Transmit Enable - MII 1. External controllers drive this input High to indicate data is transmitted on the MII1_TXD<3:0> pins. Ground this input if unused.
21 20 19 17	MII1_TXD0 MII1_TXD1 MII1_TXD2 MII1_TXD3	I	Transmit Data - MII 1. External controllers use these inputs to transmit data to the LXT98x3 Repeater. The LXT98x3 Repeater samples MII1_TXD<3:0> on the rising edge of MII1_TXCLK, when MII1_TXEN is High.
14	MII1_COL	O	Collision - MII 1. The LXT98x3 Repeater drives this signal High to indicate a collision occurred.
13	MII1_CRS	O	Carrier Sense - MII 1. Active High signal indicates LXT98x3 Repeater is transmitting or receiving.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. NC = No Clamp. Pad does not clamp input in the absence of power.</p> <p>2. Pins are 5V tolerant, unless indicated.</p>			

Table 2 MII #2 Signal Descriptions

Pin	Symbol	Type ^{1, 2}	Description
18	MII2_SPD	I PU	Speed Select - MII 2. This signal is sensed at power up, hardware reset, and software reset. Selects operating speed of the respective MII (MAC) interface. High = 100 Mbps. Low = 10 Mbps.
205 206 207 208	MII2_RXD0 MII2_RXD1 MII2_RXD2 MII2_RXD3	O	Receive Data - MII 2. The LXT98x3 Repeater transmits received data to the controller on these outputs. Data is driven on the falling edge of MII2_RXCLK.
204	MII2_RXDV	O	Receive Data Valid - MII 2. Active High signal, synchronous to MII2_RXCLK, indicates valid data on MII2_RXD<3:0>.
203	MII2_RXCLK	O	Receive Clock - MII 2. MII receive clock for expansion port. This is a 2.5 or 25 MHz clock derived from the CLK25 input (refer to Table 7 on page 17).
202	MII2_RXER	O	Receive Error - MII 2. Active High signal, synchronous to MII2_RXCLK, indicates invalid data on MII2_RXD<3:0>.
197	MII2_TXER	I	Transmit Error - MII 2. MII2_TXER is a 100M-only signal. The MAC asserts this input when errors occurs in the transmit data stream. The LXT98x3 Repeater sends 'Invalid Code Symbols' on the line.
196	MII2_TXCLK	O	Transmit Clock - MII 2. This is a 2.5 or 25 MHz clock derived from the CLK25 input (refer to Table 7 on page 17).
195	MII2_TXEN	I	Transmit Enable - MII 2. External controllers drive this input High to indicate data is transmitted on the MII2_TXD<3:0> pins. Ground this input if unused.
194 193 192 191	MII2_TXD0 MII2_TXD1 MII2_TXD2 MII2_TXD3	I	Transmit Data - MII 2. External controllers use these inputs to transmit data to the LXT98x3 Repeater. The LXT98x3 Repeater samples MII2_TXD<3:0> on the rising edge of MII2_TXCLK, when MII2_TXEN is High.
188	MII2_COL	O	Collision - MII 2. The LXT98x3 Repeater drives this signal High to indicate a collision occurred.
187	MII2_CRS	O	Carrier Sense - MII 2. Active High signal indicates LXT98x3 Repeater is transmitting or receiving.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. NC = No Clamp. Pad does not clamp input in the absence of power.</p> <p>2. Pins are 5V tolerant, unless indicated.</p>			

Table 3 Inter-Repeater Backplane Signal Descriptions (Sheet 1 of 3)

Pin	Symbol	Type ^{1, 2}	Description
Common IRB Signals			
39	COMP_SEL	AI	Compatibility Mode Select. 3.3V on this pin causes the $\overline{\text{IRCFSBP}}$ signals to operate in 3.3V only mode. 5V on this pin causes the IR100CFSBP or IR10CFSBP signals to operate in 5V backwards compatibility mode with LXT98x3 Repeater devices.
100 Mbps IRB Signals			
36	$\overline{\text{IR100CFS3}}$	A I/O OD	100 Mbps IRB Collision Force Sense. A three-level signal that determines number of active ports on the "logical" repeater. High level (3.3V) indicates no ports active; Mid level (approx. 1.6V) indicates one port active; Low level (0V) indicates more than one port active, resulting in a collision. This signal requires a 215Ω pull-up resistor, and connects between ICs on the same board.
37	$\overline{\text{IR100CFSBP}}$	A I/O OD	100 Mbps IRB Collision Force Sense - Backplane. This three-level signal functions the same as $\overline{\text{IR100CFS}}$; however, it connects between ICs with FPS = 0, on different boards. IR100CFSBP requires a single 91Ω pull-up resistor in each stack. This signal can be set in either 5V or 3.3V modes by the COMP_SEL pin.
38	$\overline{\text{IR100SNGL}}$	I/O Schmitt PU	100 Mbps Single Driver State. This active Low signal is asserted by the device with FPS = 0 when a packet is received from one or more ports. Do not connect this signal between boards.
40	$\overline{\text{IR100COL}}$	I/O Schmitt PU	100 Mbps Multiple Driver State. This active Low signal is asserted by the device with FPS = 0 when a packet is being received from more than one port (collision). Do not connect this signal between boards.
41	IR100DEN	O OD	100 Mbps IRB Driver Enable. This output provides directional control for an external bidirectional transceiver (74LVT245) used to buffer the 100 Mbps IRB in multi-board applications. It must be pulled up by a 330Ω resistor. When there are multiple devices on one board, tie all IR100DEN outputs together. If IR100DEN is tied directly to the DIR pin on a 74LVT245, attach the on-board IR100DAT, IR100CLK, and IR100DV signals to the "B" side of the 74LVT245, and connect the off-board signals to the "A" side of the 74LVT245.
42	$\overline{\text{IR100DV}}$	I/O Schmitt OD PU	100 Mbps IRB Data Valid. This active Low signal indicates port activity on the repeater. IR100DV frames the clock and data of the packet on the backplane. This signal requires a 300Ω pull-up resistor.
43 44 45 48 49	IR100DAT0 IR100DAT1 IR100DAT2 IR100DAT3 IR100DAT4	I/O Tri-state Schmitt PU	100 Mbps IRB Data. These bidirectional signals carry 5-bit data on the 100 Mbps IRB. Data is driven on the falling edge and sampled on the rising edge of IR100CLK. Buffer these signals between boards.
50	IR100CLK	I/O Tri-state Schmitt PD	100 Mbps IRB Clock. This bidirectional, non-continuous, 25 MHz clock is recovered from received network traffic. Schmitt triggering is used to increase noise immunity. This signal must be pulled to VCC when idle. One 1 kΩ pull-up resistor on both sides of a 74LVT245 buffer is recommended.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. Even if the IRB is not used, required pull-up resistors must be installed as listed above. NC = No Clamp. Pad does not clamp input in the absence of power.</p> <p>2. Pins are 5V tolerant, unless indicated.</p> <p>3. $\overline{\text{IR100CFS}}$ is not 5V tolerant.</p> <p>4. IR10CFS is not 5V tolerant.</p>			

Table 3 Inter-Repeater Backplane Signal Descriptions (Sheet 2 of 3)

Pin	Symbol	Type ^{1, 2}	Description
10 Mbps IRB Signals			
11	IR10DAT	I/O OD PD	10 Mbps IRB Data. This bidirectional signal carries data on the 10 Mbps IRB. Data is driven and sampled on the rising edge of the corresponding IRCLK. This signal must be pulled High by a 330Ω resistor. Buffer this signal between boards.
12	IR10CLK	I/O Tri-state Schmitt PD	10 Mbps IRB Clock. This bidirectional, non-continuous, 10 MHz clock is recovered from received network traffic. During idle periods, the output is high-impedance. Schmitt triggering is used to increase noise immunity.
6	$\overline{\text{IR10DEN}}$	O OD	10 Mbps IRB Driver Enable. This output provides directional control for an external bidirectional transceiver (74LVT245) used to buffer the IRBs in multi-board applications. It must be pulled up by a 330Ω resistor. When there are multiple devices on one board, tie all IR10DEN outputs together. If IR10DEN is tied directly to the DIR pin on a 74LVT245, attach the on-board IR10DAT, IR10CLK and IR10ENA signals to the "B" side of the 74LVT245, and connect the off-board signals to the "A" side of the 74LVT245.
10	$\overline{\text{IR10ENA}}$	I/O OD PU	10 Mbps IRB Enable. This active Low output indicates carrier presence on the IRB. A 330Ω pull-up resistor is required to pull the IR10ENA output High when the IRB is idle. When there are multiple devices, tie all IR10ENA outputs together. Buffer these signals between boards.
3	$\overline{\text{IR10COL}}$	I/O OD PU	10 Mbps IRB Collision. This output is driven Low to indicate a collision occurred on the 10 Mbps segment. A 330Ω resistor is required on each board to pull this signal High when there is no collision. Do not connect between boards and do not buffer.
4	$\overline{\text{IR10COLBP}}$	I/O OD	10 Mbps IRB Collision - Backplane. This active Low output has the same function as IR10COL, but is used between boards. Attach this signal only from the device with FPS = 0 to the backplane or connector, <i>without buffering</i> . The output must be pulled up by one 330Ω resistor per stack.
2	$\overline{\text{IR10CFS}}$ ⁴	A, I/O OD	10 Mbps IRB Collision Force Sense. This three-state analog signal indicates transmit collision when driven Low. IR10CFS requires a 215Ω, 1% pull-up resistor. Do not connect this signal between boards and do not buffer.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. Even if the IRB is not used, required pull-up resistors must be installed as listed above. NC = No Clamp. Pad does not clamp input in the absence of power.</p> <p>2. Pins are 5V tolerant, unless indicated.</p> <p>3. $\overline{\text{IR10CFS}}$ is not 5V tolerant.</p> <p>4. IR10CFS is not 5V tolerant.</p>			

Table 3 Inter-Repeater Backplane Signal Descriptions (Sheet 3 of 3)

Pin	Symbol	Type ^{1, 2}	Description
5	$\overline{\text{IR10CFSBP}}$	A I/O OD	Note: 10 Mbps IRB Collision Force Sense - Backplane. Functions the same as $\overline{\text{IR10CFS}}$, but connects between boards. Attach this signal only from the device with $\overline{\text{FPS}} = 0$ to the backplane or connector, <i>without buffering</i> . This signal requires one 330 Ω , 1% pull-up resistor per stack. This signal can be set for 5V or 3.3V modes by the COMP_SEL pin.
80	MACACTIVE	I PD	Note: MAC Active. Active High input allows external ASICs to participate in 10 Mbps IRB. Driving data onto the IRB requires the external ASIC assert MACACTIVE High for one clock cycle, then assert $\overline{\text{IR10ENA}}$ Low. ASIC monitors $\overline{\text{IR10COL}}$ (active Low) for collision. By using MACACTIVE, the repeater—not the MAC—drives the three-level $\overline{\text{IR10CFS}}$ pin.
81	HOLDCOL	I/O PD	Note: Hold Collision for 10 Mbps mode. This active High signal is driven by the device with $\overline{\text{FPS}} = 0$ to extend a non-local transmit collision to other devices on the same board. Do not attach the HOLDCOL signals from different boards together.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. Even if the IRB is not used, required pull-up resistors must be installed as listed above. NC = No Clamp. Pad does not clamp input in the absence of power. 2. Pins are 5V tolerant, unless indicated. 3. $\overline{\text{IR100CFS}}$ is not 5V tolerant. 4. $\overline{\text{IR10CFS}}$ is not 5V tolerant.</p>			

Table 4 Twisted-Pair Port Signal Descriptions

Pin	Symbol	Type ¹	Description		
107, 108 111, 110 121, 122 125, 124 136, 137 140, 139 150, 151 154, 153	TPOP1, TPON1 TPOP2, TPON2 TPOP3, TPON3 TPOP4, TPON4 TPOP5, TPON5 TPOP6, TPON6 TPOP7, TPON7 TPOP8, TPON8	AO	Twisted-Pair Outputs - Ports 1 through 8. These pins are the positive and negative outputs from the respective ports' twisted-pair line drivers. For unused ports, these pins can be left open.		
104, 105 115, 114 118, 119 129, 128 132, 133 143, 142 146, 147 157, 156	TPIP1, TPIN1 TPIP2, TPIN2 TPIP3, TPIN3 TPIP4, TPIN4 TPIP5, TPIN5 TPIP6, TPIN6 TPIP7, TPIN7 TPIP8, TPIN8	AI	Twisted-Pair Inputs - Ports 1 through 8. These pins are the positive and negative inputs to the respective ports' twisted-pair receivers. For unused ports, tie together with 100Ω resistors and float.		
160 159	TxSLEW_1 TxSLEW_0	I PD	Tx Output Slew Controls 0 and 1. These pins select the TX output slew rate (rise and fall time) as follows:		
			TxSLEW_1	TxSLEW_0	Slew Rate (Rise and Fall Time)
			0	0	2.5 ns
			0	1	3.1 ns
			1	0	3.7 ns
1	1	4.3 ns			
1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, AO = Analog Output, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. NC = No Clamp. Pad does not clamp input in the absence of power.					

Table 5 LED Signal Descriptions (Sheet 1 of 2)

Pin	Symbol	Type ^{1, 2}	Description
184 185	LEDSEL0 LEDSEL1	I ³ O - OD/OS	LED Mode Select - Input. See Note 3 in footer below. 00 = Mode 1, 01 = Mode 2, 10 = Mode 3, 11 = Mode 4 These pins are shared with the LEDACT100, LEDCOL10 outputs.
175	LEDABGSEL	I ³ O - OD/OS	LED Activity Bar Graph Mode Select - Input. See Note 2 in footer below. 0 = Base-10 Mode, 1 = Base-2 Mode Refer to Section 3.6.4.2, Activity Graph LEDs, on page 25 This pin is shared with the Port8_LED2 output.
183	AUTOBLINK	I ³ O - OD/OS	LED Blink Mode Select - Input. See Note 3 in footer below. 0 = Auto blink on, 1 = Auto blink off This pin is shared with the LEDACT100, LEDCOL10 outputs.
83	LEDDAT	O	LED Data. Serial data stream that is shifted into external Serial-to-Parallel LED drivers. See Section 3.6.3, Serial LED Interface, on page 23 .
84	LEDLAT	O	LED Latch. Parallel load clock for external Serial-to-Parallel LED drivers. See Section 3.6.3, Serial LED Interface, on page 23 .
82	LEDCLK	O	LED Clock. Serial data stream clock for external Serial-to-Parallel LED drivers. See Section 3.6.3, Serial LED Interface, on page 23 .
176 171 167 163 101 97 93 89	PORT8_LED1 PORT7_LED1 PORT6_LED1 PORT5_LED1 PORT4_LED1 PORT3_LED1 PORT2_LED1 PORT1_LED1	O OD	LED Driver 1 - Ports 1 through 8. Programmable LED driver. Active Low. See Section , on page 25 . Port8_LED1 must be pulled High via a 100–500 kΩ resistor if LED circuit not used.
175 170 166 162 100 96 92 88	PORT8_LED2 PORT7_LED2 PORT6_LED2 PORT5_LED2 PORT4_LED2 PORT3_LED2 PORT2_LED2 PORT1_LED2	O OD	LED Driver 2 - Ports 1 through 8. Programmable LED driver. Active Low. See Section , on page 25 . The Port8_LED2 pin is shared with the LEDABGSEL configuration input.
174 169 165 161 99 95 91 87	PORT8_LED3 PORT7_LED3 PORT6_LED3 PORT5_LED3 PORT4_LED3 PORT3_LED3 PORT2_LED3 PORT1_LED3	O OD	LED Driver 3 - Ports 1 through 8. Programmable LED driver. Active Low. See Section , on page 25 . Port8_LED3 must be pulled High via a 100–500 kΩ resistor if LED circuit not used.
185	COL10_LED	I O - OD/OS	10M Collision LED Driver. Active output indicates collision on 10M segment. This pin is shared with the LEDSEL1 configuration input.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. Even if the IRB is not used, required pull-up resistors must be installed as listed above. NC = No Clamp. Pad does not clamp input in the absence of power. 2. Pins are 5V tolerant, unless indicated. 3. Input must be static; Refer to Section 4.2.9.2, LED Pins Multiplexed with Configuration Inputs, on page 39 for information on pin use.</p>			

Table 5 LED Signal Descriptions (Sheet 2 of 2)

Pin	Symbol	Type ^{1, 2}	Description
186	COL100_LED	I O - OD/OS	100M Collision LED Driver. Active output indicates collision on 100M segment.
183	ACT10_LED	I O - OD/OS	10M Activity LED Driver. Active output indicates activity on 10M segment. This pin is shared with the AUTOBLINK configuration input (refer to Note 3 below).
184	ACT100_LED	I O - OD/OS	100M Activity LED Driver. Active output indicates activity on 100M segment. This pin is shared with the LEDSEL0 configuration input (refer to Note 3 below).

1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. Even if the IRB is not used, required pull-up resistors must be installed as listed above.
 NC = No Clamp. Pad does not clamp input in the absence of power.
 2. Pins are 5V tolerant, unless indicated.
 3. Input must be static; Refer to [Section 4.2.9.2, LED Pins Multiplexed with Configuration Inputs, on page 39](#) for information on pin use.

Table 6 Power Supply and Indication Signal Descriptions (Sheet 1 of 2)

Pin	Symbol	Type ^{1, 2}	Description
8, 16, 28, 47, 61, 74, 76, 77, 85, 173, 177, 180, 190, 200	VCC	-	Power Supply Inputs. Each of these pins must be connected to a common +3.3 VDC power supply. A de-coupling capacitor to digital ground should be supplied for every one of these pins.
106, 113, 120, 127, 134, 141, 148, 155	VCCR	-	Analog Supply Inputs - Receive. Each of these pins must be connected to a common +3.3 VDC power supply. A de-coupling capacitor to GND should be supplied for every one of these pins. Use ferrite beads to create a separate analog VCC plane.
112, 126, 135, 149	VCCT	-	Analog Supply Inputs - Transmit. Each of these pins must be connected to a common +3.3 VDC power supply. A de-coupling capacitor to GND should be supplied for every one of these pins. Use ferrite beads to create a separate analog VCC plane.
1, 7, 15, 27, 46, 62, 75, 86, 90, 94, 98, 103, 109, 116, 117, 123, 130, 131, 138, 144, 145, 152, 158, 164, 168, 172, 179, 181, 189, 199	GND	-	Ground. Connect each of these pins to system ground plane.

1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up.
 NC = No Clamp. Pad does not clamp input in the absence of power.
 2. Pins are 5V tolerant, unless indicated.

Table 6 Power Supply and Indication Signal Descriptions (Sheet 2 of 2)

Pin	Symbol	Type ^{1, 2}	Description
102	RBIAS	A	RBIAS. Used to provide bias current for internal circuitry. The 100 μ A bias current is provided through an external 22.1 k Ω , 1% resistor to GND.
79	RPS_PRES	I PD	Redundant Power Supply Present. Active High input indicates presence of redundant power supply. Tie Low if not used.
78	$\overline{\text{RPS_FAULT}}$	I PU	Redundant Power Supply Fault. Active Low input indicates redundant power supply fault. The state of this input is reflected in the RPS_LED output (refer to LED section). Tie High if not used.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. NC = No Clamp. Pad does not clamp input in the absence of power.</p> <p>2. Pins are 5V tolerant, unless indicated.</p>			

Table 7 Miscellaneous Signal Descriptions

Pin	Symbol	Type ^{1, 2}	Description
53	$\overline{\text{RESET}}$	I Schmitt	Reset. This active Low input causes internal circuits, state machines and counters to reset (address tracking registers do not reset). On power-up, devices should not be brought out of reset until the power supply stabilizes to 3.3V. When there are multiple devices, it is recommended all be supplied by a common reset driven by an 'LS14 or similar device.
54	CLK25	I Schmitt	25 MHz system clock. Refer to Table 21 on page 45 .
72	$\overline{\text{FPS}}$	I TTL	First Position Select. In multi-chip configurations, this pin identifies one device on each board that drives the HOLDCOL signal to extend non-local collisions to other devices on the board. Set Low for first device on the PCB. Set High for all other devices on the PCB.
25, 33, 51, 52, 55-60, 63-71, 73, 178, 182, 198, 201	N/C	-	No Connects. Leave these pins unconnected.
<p>1. I = Input, O = Output, I/O = Input/Output, D = Digital, A = Analog, AI = Analog Input, A I/O = Analog Input/Output, OD = Open Drain, OS = Open Source, PD = Pull Down, PU = Pull Up. NC = No Clamp. Pad does not clamp input in the absence of power.</p> <p>2. Pins are 5V tolerant, unless indicated.</p>			

3.0 Functional Description

3.1 Introduction

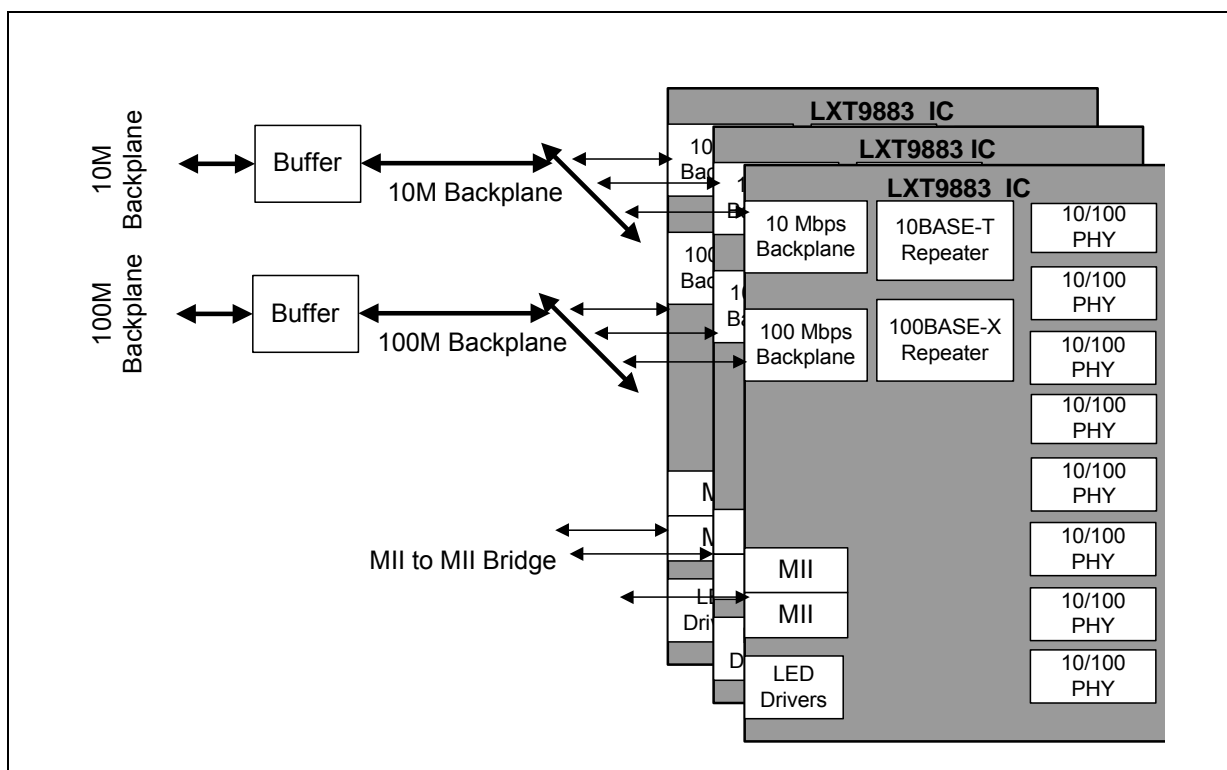
As a fully integrated IEEE 802.3 compliant repeater capable of 10 Mbps and 100 Mbps operation, the Cortina Systems® LXT98x3 Advanced 10/100 Unmanaged Repeater (LXT98x3 Repeater) is a versatile device allowing great flexibility in Ethernet design solutions. Figure 3 shows a typical application. Refer to Section 4.0, *Application Information*, on page 34 for specific circuit implementations.

This multi-port repeater provides six (LXT9863 Repeater) or eight (LXT9883 Repeater) 10BASE-T/100BASE-TX ports. In addition, each device also provides two Media Independent Interface (MII) expansion ports that may be connected to 10/100 MACs.

The LXT98x3 Repeater provides two repeater state machines and two Inter-Repeater Backplanes (IRB) on a single chip—one for 10 Mbps and one for 100 Mbps operation. The 100 Mbps repeater meets IEEE 802.3 Class II requirements. The auto-negotiation capability of the LXT98x3 Repeater allows it to communicate with connected nodes and configure itself accordingly.

The segmented backplane simplifies dual-speed operation, and allows multiple devices to be stacked and function as one logical Class II repeater. Up to 240 ports (192 TP ports and 48 MII ports) can be supported in a single stack.

Figure 3 Typical LXT9883 Repeater Architecture



3.2 Port Configuration

The LXT98x3 Repeater powers up in auto-negotiation mode for all twisted-pair ports.

3.2.1 Auto-Negotiation

All TP ports on power-up are configured to establish link via auto-negotiation. The port and link partner establish link conditions by exchanging Fast Link Pulse (FLP) bursts. Each FLP burst contains 16 bits of data advertising the port's capabilities. If the link partner does not support auto-negotiation, the LXT98x3 Repeater determines link state by listening for 100 Mbps IDLE symbols or 10 Mbps link pulses. If it detects either of these signals, it configures the port accordingly.

3.2.2 Link Establishment and Port Connection

Once a port establishes link, the LXT98x3 Repeater automatically connects it to the appropriate repeater state machine. If link loss is detected and auto-negotiation is enabled, the port returns to the auto-negotiation state.

3.3 Interface Descriptions

The LXT9883 Repeater and LXT9863 Repeater provide eight and six network interface ports, respectively. Each port is a twisted-pair interface that directly supports 100BASE-TX (100TX) and 10BASE-T (10T) Ethernet applications and fully complies with IEEE 802.3 standards. A common termination circuit is used.

3.3.1 Twisted-Pair Interface

The LXT98x3 Repeater pinout is optimized for dual-height RJ-45 connectors. The twisted-pair interface for each port consists of two differential signal pairs — one for transmit and one for receive. The transmit signal pair is TPOP/TPON, the receive signal pair is TPIP/TPIN.

The transmitter requires magnetics with 1:1 turns ratio. The center tap of the primary side of the transmit winding must be tied to a quiet VCC for proper operation.

The receiver requires magnetics with a 1:1 turns ratio, and a load of 100 Ω . When the twisted-pair port is enabled, the receiver actively biases its inputs to approximately 2.8V. A 4 k Ω load is always present across the TPIP/TPIN pair.

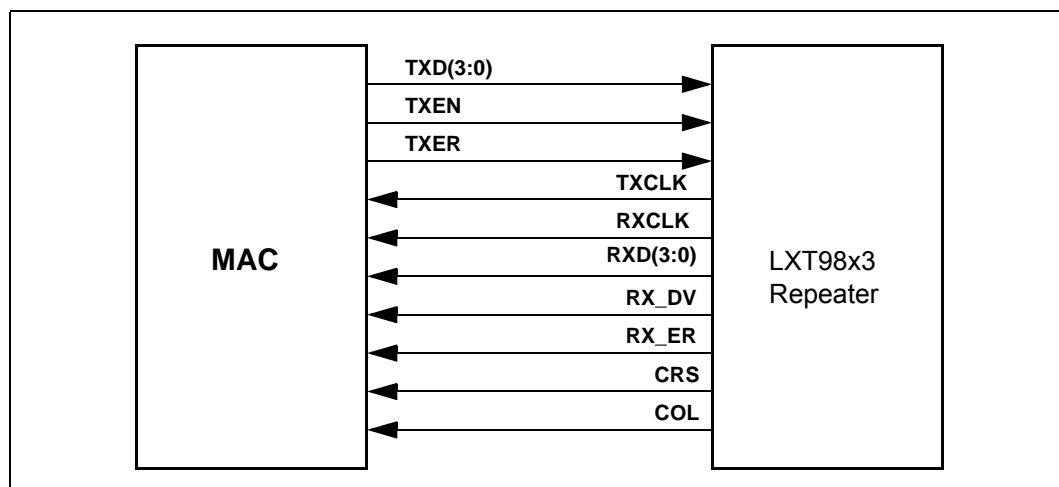
When used in 100TX applications, the LXT98x3 Repeater sends and receives a continuous, scrambled 125 Mbps MLT-3 waveform on this interface. In the absence of data, IDLE symbols are sent and received in order to maintain the link.

When used in 10T applications, the LXT98x3 Repeater sends and receives a non-continuous, 10 Mbps Manchester-encoded waveform. To maintain link during idle periods, the LXT98x3 Repeater sends link pulses every 16 ms, and expects to receive them every 10 to 20 ms. Each 10T port automatically detects and sends link pulses, and disables its transmitter if link pulses are not detected. Each 10BASE-T port can detect and automatically correct for polarity reversal on the TPIP/N inputs. The 10BASE-T interface provides integrated filters to facilitate low-cost stack designs to meet EMI requirements.

3.3.2 Media Independent Interface

The LXT98x3 Repeater has two identical MII interfaces. The MII has been designed to allow expansion to a Media Access Controller (MAC) as shown in Figure 4. This interface is not MDIO/MDC capable. These MII ports can be set via hardware tie ups/downs to be either 10 Mbps or 100 Mbps. These ports are not the full MII drive strength and are intended only for point-to-point links.

Figure 4 MII Interface



3.4 Repeater Operation

The LXT98x3 Repeater contains two internal repeater state machines — one operating at 10 Mbps and the other at 100 Mbps. The LXT98x3 Repeater automatically switches each port to the correct repeater, once the operational state of that port has been determined. Each repeater connects all ports configured to the same speed (including the MII), and the corresponding Inter-Repeater Backplane. Both repeaters perform the standard jabber and partition functions.

3.4.1 100 Mbps Repeater Operation

The LXT98x3 Repeater contains a complete 100 Mbps Repeater State Machine (100RSM) that is fully IEEE 802.3 Class II compliant. Any port configured for 100 Mbps operation is automatically connected to the 100 Mbps Repeater. This includes any of the eight media and two MII ports configured for 100 Mbps operation.

The 100 Mbps RSM has its own Inter-Repeater Backplane (100IRB). Multiple LXT98x3 Repeaters can be cascaded on the 100IRB and operate as one repeater segment. Data from any port is forwarded to all other ports in the cascade. The 100IRB is a 5-bit symbol-mode interface. It is designed to be stackable.

The LXT98x3 Repeater performs the following 100 Mbps repeater functions:

- Signal amplification, wave-shape restoration, and data-frame forwarding.
- SOP, SOJ, EOP, EOJ delay < 46BT; class II compliant.
- Collision Enforcement. During a 100 Mbps collision, the LXT98x3 Repeater drives a 0101 jam signal (encoded as Data 5 on TX links) to all ports until the collision ends. There is no minimum enforcement time.

- Partition. The LXT98x3 Repeater partitions any port that participates in excess of 60 consecutive collisions or one long collision approximately 575.2 μ s long. Once partitioned, the LXT98x3 Repeater monitors and transmits to the port, but does not repeat data received from the port until it un-partitions.
- Un-partition. The un-partition algorithm, which complies with IEEE specification 802.3aa, un-partitions a port on *either* transmit or receive of at least 450-560 bits without collision.
- Isolate. The LXT98x3 Repeater isolates any port receiving more than two successive false carrier events. A false carrier event is a packet that does not start with a /J/K symbol pair.
- Un-isolate. The LXT98x3 Repeater un-isolates a port that remains in the IDLE state for 33000 +/- 25% BT or that receives a valid frame at least 450-500 BT in length.
- Jabber. The LXT98x3 Repeater ignores any receiver remaining active for more than 57,500 bit times. The LXT98x3 Repeater exits this state when either one of the following conditions is met:
 - On power-up reset
 - When carrier is no longer detected

3.4.2 10 Mbps Repeater Operation

The LXT98x3 Repeater contains a complete 10 Mbps Repeater State Machine (10RSM) that is fully IEEE 802.3 compliant. Any port configured for 10 Mbps operation is automatically connected to the 10 Mbps Repeater. This includes any of the media and MII ports configured for 10 Mbps operation.

The 10RSM has its own Inter-Repeater Backplane (10IRB). Multiple LXT98x3 Repeaters can be cascaded on the 10IRB and operate as one repeater segment. Data from any port is forwarded to all other ports in the cascade.

The LXT98x3 Repeater performs the following 10 Mbps repeater functions:

- Signal amplification, wave-shape restoration, and data-frame forwarding.
- Preamble regeneration. All outgoing packets have a minimum 56-bit preamble and 8-bit SFD.
- SOP, SOJ, EOP, EOJ delays meet IEEE 802.3 section 9.5.5 and 9.5.6 requirements.
- Collision Enforcement. During a 10 Mbps collision, the LXT98x3 Repeater drives a jam signal ("1010") to all ports for a minimum of 96 bit times until the collision ends.
- Partition. The LXT98x3 Repeater partitions any port in excess of 31 consecutive collisions. Once partitioned, the LXT98x3 Repeater continues monitoring and transmitting to the port, but does not repeat data received from the port until it properly un-partitions. (Also partitions for excessive collision length.)
- Un-partition. The algorithm, which complies with the IEEE 802.3 specification, un-partitions a port when data can be either received or transmitted from the port for 450-560 bit times without a collision on that port.
- Jabber. The LXT98x3 Repeater asserts a minimum-IFG idle period when a port transmits for longer than 40,000 to 75,000 bit times.

3.5 Requirements

3.5.1 Power

The LXT98x3 Repeater has four types of +3.3V power supply input pins: two digital (VCC, GND) and two analog (VCCR, VCCT). These inputs may be supplied from a single source. Ferrite beads should be used to separate the analog and digital planes. These supplies should be clean.

Each supply input should be decoupled to ground. Refer to [Table 6 on page 16](#) for power and ground pin assignments, and to the [Section 4.1, General Design Guidelines, on page 34](#).

3.5.2 Clock

A stable, external 25MHz reference clock source (TTL) is required to the CLK25 pin. The reference clock is used to generate transmit signals and recover receive signals. A crystal-based clock is recommended over a derived clock (i.e., PLL-based) to minimize transmit jitter. Refer to [Table 18 on page 38](#) for a list of recommended oscillators and to [Table 21 on page 45](#) for clock timing requirements.

3.5.3 Bias Resistor

The RBIAS input requires a 22.1 k Ω , 1% resistor connected to ground.

3.5.4 Reset

At power-up, the reset input must be held Low until VCC reaches at least 3.15V. A buffer should be used to drive reset if there are multiple LXT98x3 Repeater devices. The clock must be active.

3.5.5 IRB Bus Pull-ups

Even when the LXT98x3 Repeater is used in a stand-alone configuration, pull-up resistors are required on the IRB signals. See [Figure 16](#) and [Figure 17 on page 44](#).

100 Mbps IRB	10 Mbps IRB
IR100CFS	IR10DAT
IR100CFSBP	IR10ENA
IR100DV	IR10COL
IR100CLK	IR10CFS
	IR10COLBP
	IR10CFSBP

3.6 LED Operation

The LXT98x3 Repeater drives the most commonly used LEDs directly (see [Section , , on page 25](#)). The less frequently used LEDs are optionally driven via a serial bus to inexpensive Serial-to-Parallel devices (see “Serial LEDs” on this page).

3.6.1 LEDs at Start-up

For approximately 2 seconds after the LXT98x3 Repeater is reset, all LEDs are driven to the ON state. This start-up routine is an LED check.

3.6.2 LED Event Stretching

Short lived LED status events are stretched so they may be observed by the human eye. Refer to the LED1, 2, 3 Modes section for stretching specifics.

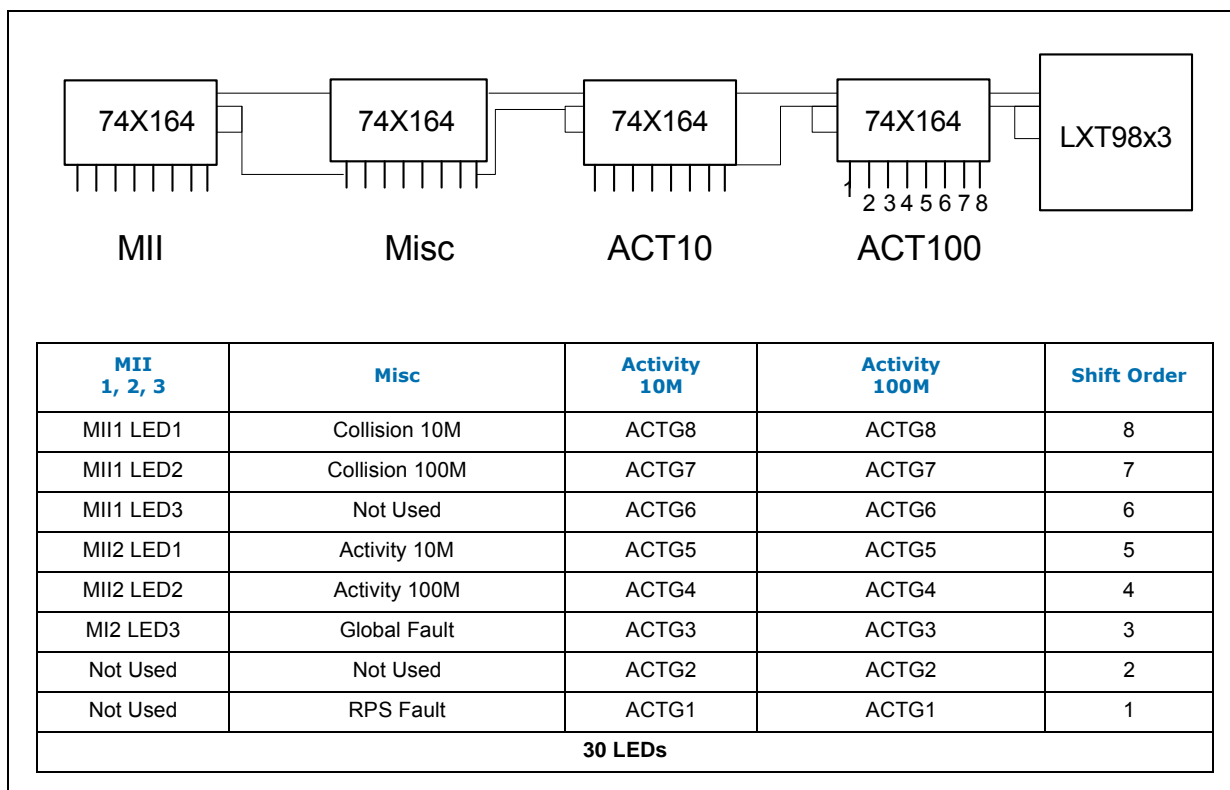
3.6.3 Serial LED Interface

The LXT98x3 Repeater provides a serial interface to drive additional LEDs via external 8-bit Serial-to-Parallel converters. A maximum of 30 LEDs can be driven, using four S/P devices. Collision10/100, Activity10/100 status indications are output on multiplexed configuration pins and are duplicated on the Serial Port (see [Section 4.2.9.2, LED Pins Multiplexed with Configuration Inputs](#), on page 39).

3.6.4 Serial Shifting

Figure 5 shows the Serial LED shift loading.

Figure 5 Serial LED Shift Loading



3.6.4.1 Serial LED Signals

The LED serial interface bus consists of three LXT98x3 Repeater outputs: clock (LEDCLK), parallel load clock (LEDLAT), and output data (LEDDAT). Refer to [Table 5 on page 15](#) for signal descriptions and to [Figure 14 on page 41](#) for an illustration of the LED serial interface circuit. Refer to [Figure 6](#) and [Table 8](#) for details on the LED serial bit stream.

Figure 6 Serial LED Port Signaling

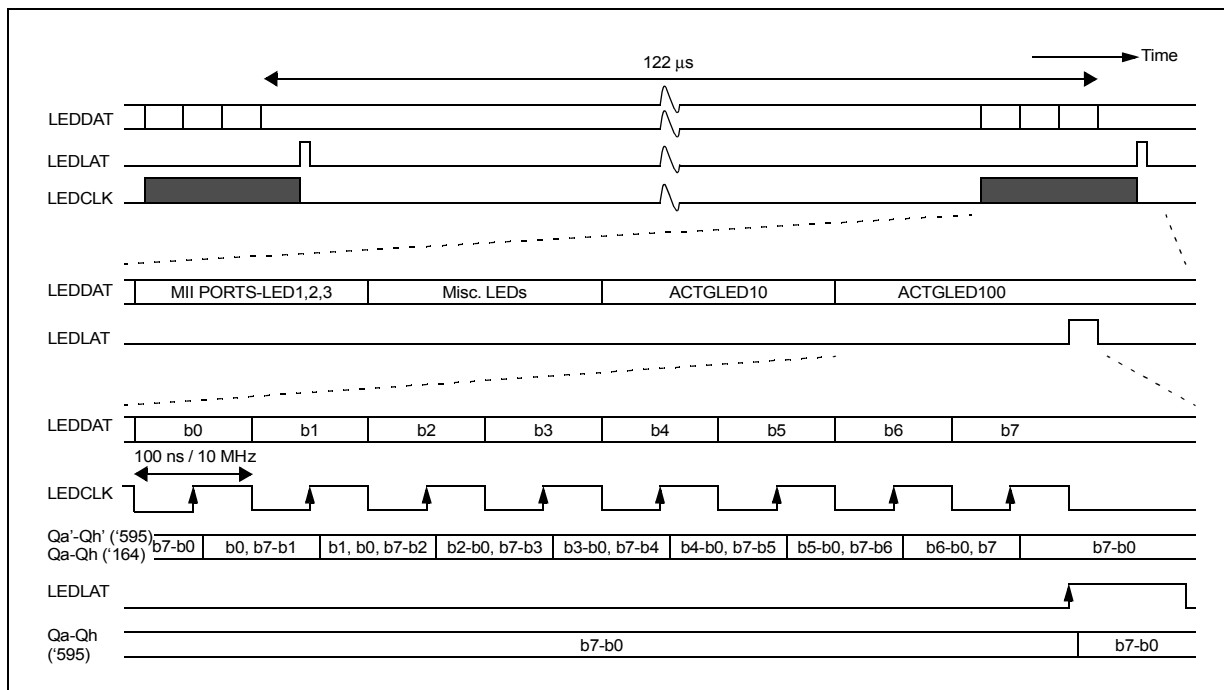


Table 8 Serial LED Port Bit Stream

Bit	MII Ports-LED1, 2, 3	Misc.	ACTGLED10	ACTGLED100
7	MII Port 1 - LED1	Collision - 10M ¹	ACTG8	ACTG8
6	MII Port 1 - LED2	Collision - 100M ¹	ACTG7	ACTG7
5	MII Port 1 - LED3	Not Used	ACTG6	ACTG6
4	MII Port 2 - LED1	Activity - 10M ¹	ACTG5	ACTG5
3	MII Port 2 - LED2	Activity - 100M ¹	ACTG4	ACTG4
2	MII Port 2 - LED3	Global Fault	ACTG3	ACTG3
1	Not Used	Not Used	ACTG2	ACTG2
0	Not Used	RPS Fault	ACTG1	ACTG1

1. These LEDs are multiplexed with Configuration Inputs.

3.6.4.2 Activity Graph LEDs

The ACTGLED10 and ACTGLED100 LEDs are for activity bar graphing. The activity information is integrated and updated over a period of 328.125ms, which has the effect of smoothing out the activity. LEDs are provided for both the 10 Mbps and 100 Mbps segments.

There are two display modes for the activity bar graphs, Base-2 and Base-10. The modes are selected via the LEDABGSEL pin. Refer to [Table 9](#) for details. Each step LED on the bar graph is lit when the percent activity value associated with that step is met or exceeded.

Table 9 ACTGLED Display Modes

LED	LEDABGSEL = 0 (Base-10)	LEDABGSEL = 1 (Base-2)
ACTG 8	60+% Activity	80+% Activity
ACTG 7	50% Activity	64% Activity
ACTG 6	40% Activity	32% Activity
ACTG 5	30% Activity	16% Activity
ACTG 4	20% Activity	8% Activity
ACTG 3	10% Activity	4% Activity
ACTG 2	5% Activity	2% Activity
ACTG 1	1% Activity	1% Activity

3.6.5 Direct Drive LEDs

The LXT98x3 Repeater provides three direct drive LEDs for each port (PORT n _LED1:3), excluding the two MII ports. Four additional segment LEDs indicate Collision 10/100 and Activity 10/100.) The per-port LEDs are updated simultaneously to illustrate clear, non-overlapping status.

The following device pins are multifunctional (input = configuration; output = LED driver): COL10_LED (185), ACT10_LED (183), ACT100_LED (184), and, PORT8_LED2 (175).

The drive level is determined by the particular input configuration function of the respective pin. Collision and Activity indications for both 10M and 100M segments are available in both serial and direct drive.

3.6.6 LED Modes

The four available LED modes are described in [Table 11 - Table 15](#). Hardware pins provide global LED mode control. Refer to [Table 5 on page 15](#) for pin assignments and signal description. [Table 10](#) defines terms used to describe LED operation.

Table 10 LED Terms

Term	Definition
Port_Enabled	True if port is enabled.
Link_OK	True if link is enabled and link is detected. Always true for MII port.
Port_Partitioned	True if port has been auto partitioned (10Mb mode). True if port has been auto partitioned or isolated (100Mb mode).
Port_Is_TP	True if port is a twisted-pair port.
RPS_Present	True if redundant power supply is switched in.
RPS_Fault	True if redundant power supply has a fault.
Rcv_Activity	True if twisted-pair port on this device is receiving a packet.

3.6.6.1 LED Mode 1

Mode 1 operations are described in [Table 11](#).

Table 11 LED Mode 1 Indications (Sheet 1 of 2)

LED	Operating Mode	Hardware Control ¹		
		On	Blink	Off
PORT _n LED1	10 Mbps operation	Link_OK, not Port_Partitioned	N/A	Any other state
	100 Mbps operation			
PORT _n LED2	10 Mbps operation	Link_OK, Port_Partitioned	N/A	Any other state
	100 Mbps operation			
PORT _n LED3	$\overline{\text{AUTOBLINK}}$ active	100M Link_OK	Not Link_OK (Fast Blink)	10M Link_OK
	$\overline{\text{AUTOBLINK}}$ inactive		N/A	
Collision and Activity LEDs	Any	<p>The collision and activity LEDs are on a Per Segment basis. Pulse stretchers are used to extend the on-time for the LEDs. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows.</p> <p>The collision LEDs turn on for approximately 120 μs when the LXT98x3 Repeater detects a collision on the segments. During the time that the LED is on, any additional collisions are ignored by the collision LED logic.</p> <p>The activity LEDs turn on for approximately 4 ms when the LXT98x3 Repeater detects any activity on the segments. During the time that the LED is on any additional activity is ignored by the activity LED logic.</p>		
1. Refer to Table 11: LED Terms , which defines all key terms used in this section.				

Table 11 LED Mode 1 Indications (Sheet 2 of 2)

LED	Operating Mode	Hardware Control ¹		
		On	Blink	Off
Global Fault	Any	Any Port_Partitioned or RPS_Fault and RPS_Present	N/A	Any other state
RPS Fault	Any	RPS_Present, RPS_Fault		

1. Refer to [Table 11: LED Terms](#), which defines all key terms used in this section.

3.6.6.2 LED Mode 2

Mode 2 operations are described in [Table 12](#).

Table 12 LED Mode 2 Indications

LED	Operating Mode	Hardware Control ¹		
		On	Blink	Off
PORT _n LED1	Any	10M: Port_Enabled, Link_OK, not Port_Partitioned 100M: Port_Enabled, Link_OK, not Port_Partitioned	10M: Port_Enabled, Link_OK, and Port_Partitioned (slow blink) 100M: Port_Enabled, Port_Partitioned (Slow Blink)	Any other state
PORT _n LED2		Rcv_Activity (20 ms pulse) ²	N/A	
PORT _n LED3	$\overline{\text{AUTOBLINK}}$ active	100M Link_OK	No Link_OK (Fast Blink)	10M Link_OK
	$\overline{\text{AUTOBLINK}}$ inactive		N/A	
Collision and Activity LEDs	Any	<p>The collision and activity LEDs are on a Per Segment basis. Pulse stretchers are used to extend the on-time for the LEDs. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows.</p> <p>The collision LEDs turn on for approximately 120 μs when the LXT98x3 Repeater detects a collision on the segments. During the time that the LED is on, any additional collisions are ignored by the collision LED logic.</p> <p>The activity LEDs turn on for approximately 4 ms when the LXT98x3 Repeater detects any activity on the segments. During the time that the LED is on, any additional activity is ignored by the activity LED logic.</p>		
RPS Fault	Any	PRS_Present, no RPS_Fault	PRS_Present, RPS_Fault (Slow Blink)	Not RPS_Present
Global Fault	Any	N/A	Any Port_Partitioned, any Port Isolated or RPS_Fault and RPS_Present (Slow Blink)	Any other state

1. Refer to [Table 10: LED Terms](#), which defines all key terms used in this section.
 2. Receive activity is stretched to a 20 ms wide pulse. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows.

3.6.6.3 LED Mode 3

Mode 3 operations are described in [Table 13](#).

Table 13 LED Mode 3 Indications

LED	Operating Mode	Hardware Control		
		On	Blink	Off
PORT _n LED1	10 Mbps operation	Link_OK, not Port_Partitioned	N/A	Any other state
	100 Mbps operation			
PORT _n LED2	Any	Rcv_Activity (20 ms pulse) ²	N/A	Any other state
PORT _n LED3	AUTOBLINK active	100M Link_OK	No Link_OK (Fast Blink)	10M Link_OK
	AUTOBLINK inactive	100M mode selected	N/A	10M mode selected
Collision and Activity LEDs	Any	<p>The collision and activity LEDs are on a Per Segment basis. Pulse stretchers are used to extend the on-time for the LEDs. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows.</p> <p>The collision LEDs turn on for approximately 120 μs when the LXT98x3 Repeater detects a collision on the segments. During the time that the LED is on, any additional collisions is ignored by the collision LED logic.</p> <p>The activity LEDs turn on for approximately 4 ms when the LXT98x3 Repeater detects any activity on the segments. During the time that the LED is on, any additional activity is ignored by the activity LED logic.</p>		
Global Fault	Any	Any Port_Partitioned or RPS_Fault and RPS_Present	N/A	Any other state
RPS Fault		RPS_Present, RPS_Fault		
<ol style="list-style-type: none"> 1. Refer to Table 10: LED Terms, which defines all key terms used in this section. 2. Receive activity is stretched to a 20 ms wide pulse. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows. 				

3.6.6.4 LED Mode 4

Mode 4 operations are described in [Table 14](#).

Table 14 LED Mode 4 Indications (Sheet 1 of 2)

LED	Operating Mode	Hardware Control ¹		
		On	Blink	Off
PORT _n LED1	10 Mbps operation	Link_OK, not Port_Partitioned	20 ms Blink indicates Rcv_Activity ²	Any other state
	100 Mbps operation			Any other state
PORT _n LED2	10 Mbps operation	Link_OK, Port_Partitioned	N/A	Any other state
	100 Mbps operation			
<ol style="list-style-type: none"> 1. Refer to Table 10: LED Terms, which defines all key terms used in this section. 2. Receive activity is stretched to a 20 ms wide pulse. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows. 				

Table 14 LED Mode 4 Indications (Sheet 2 of 2)

LED	Operating Mode	Hardware Control ¹		
		On	Blink	Off
PORT _n /LED3	AUTOBLINK active	100M Link_OK	No Link_OK (Fast Blink))	10M Link_OK
	AUTOBLINK inactive		N/A	
Collision and Activity LEDs	Any	<p>The collision and activity LEDs are on a Per Segment basis. Pulse stretchers are used to extend the on-time for the LEDs. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows.</p> <p>The collision LEDs turn on for approximately 120 μs when the LXT98x3 Repeater detects a collision on the segments. During the time that the LED is on, any additional collisions are ignored by the collision LED logic.</p> <p>The activity LEDs turns on for approximately 4 ms when the LXT98x3 Repeater detects any activity on the segments. During the time that the LED is on, any additional activity is ignored by the activity LED logic.</p>		
Global Fault	Any	Any port partitioned or RPS_Fault and RPS_Present	N/A	Any other state
RPS Fault	Any	RPS_Fault and RPS_Present		
<p>1. Refer to Table 10: LED Terms, which defines all key terms used in this section.</p> <p>2. Receive activity is stretched to a 20 ms wide pulse. For every on-cycle of the stretched LEDs, an off-cycle, with the same period as the on-cycle, always follows.</p>				

3.7 IRB Operation

The Inter-Repeater Backplane (IRB) allows multiple devices to operate as a single logical repeater, exchanging data and collision status information. Each segment on the LXT98x3 Repeater has its own complete, independent IRB. The backplanes use a combination of digital and analog signals as shown in [Figure 8 on page 31](#).

3.7.1 IRB Signal Types

IRB signals can be characterized by the following connection types (For Stacking and Cascading connections, see [Table 15 on page 31](#)):

- **Local**—connected between devices on the same board
- **Stack**—connected between boards
- **Full**—connected between devices in the same board *and* between boards.

3.7.2 10M-Only Operation

3.7.2.1 MAC IRB Access

The MACACTIVE pin allows an external MAC or other digital ASIC to interface directly to the 10 Mbps IRB. When the MACACTIVE pin is asserted, the LXT98x3 Repeater drives the IR10CFS and IR10CFSBP signals on behalf of the external device, allowing it to participate in collision detection functions.

3.7.3 LXT98x/91x/98xx Compatibility

The LXT98x3 Repeater devices feature low-power 3.3V design. The LXT98x and LXT91x devices operate at 5V and are incompatible with the LXT98x3 Repeater devices in cascades. The LXT98x3 Repeater devices, however, are *backwards stackable* with LXT98x and LXT91x repeaters.

Refer to [Section 4.3, Inter-Repeater Backplane Compatibility](#), on page 41.

Figure 7 100M IRB Connection

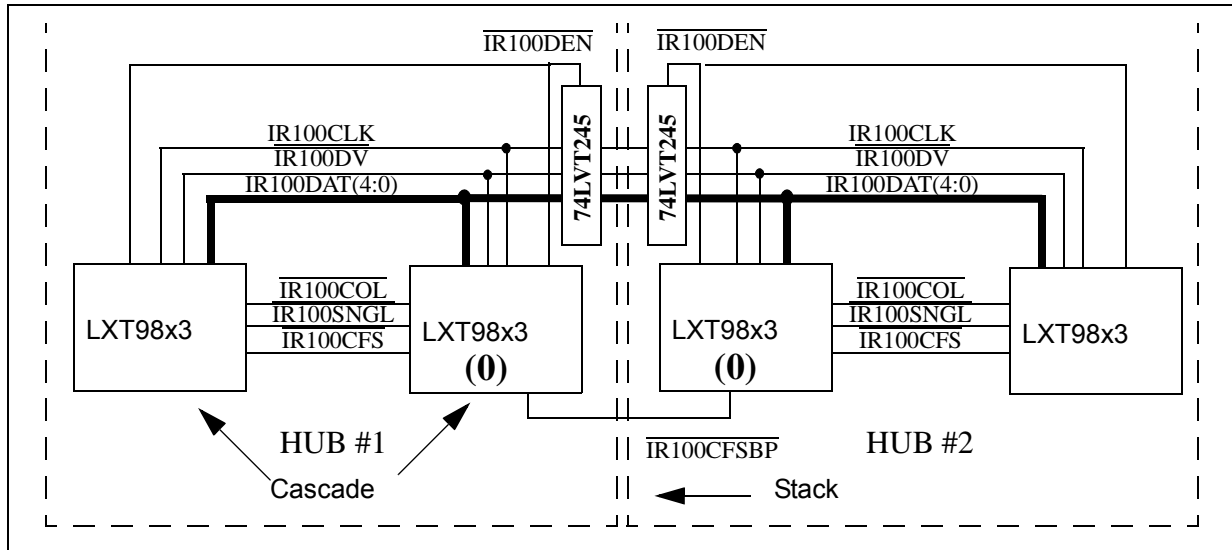


Figure 8 IRB Block Diagram

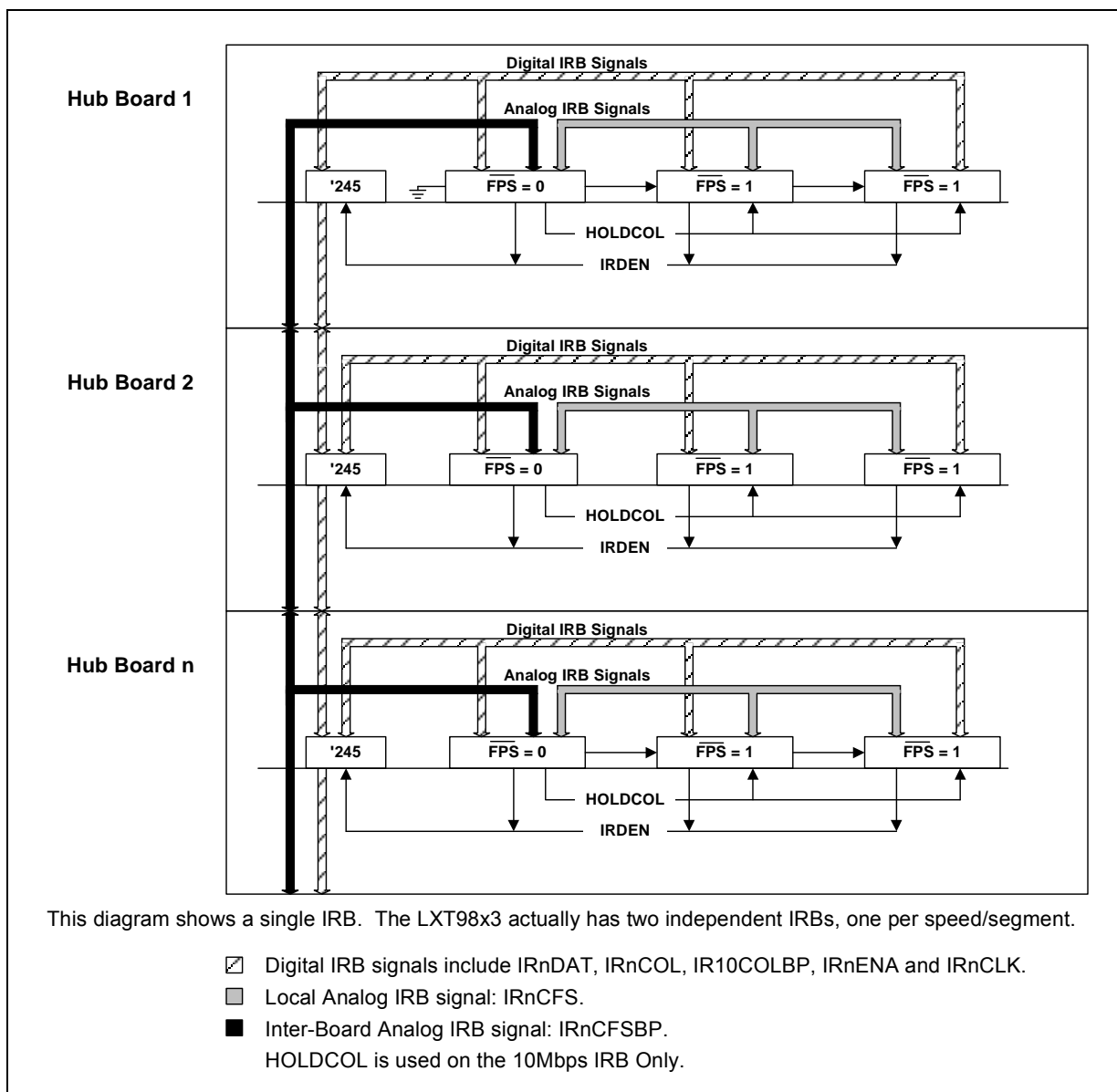


Table 15 Cascading and Stacking Connections

Signal Type	Connections Between Devices (Cascading)	Connections Between Boards (Stacking)
Local	Connect all.	<i>Do not connect.</i>
Stack	For devices with $\overline{\text{FPS}} = 0$, pull-up at each device and <i>do not interconnect.</i>	Connect devices with $\overline{\text{FPS}} = 0$ between boards. Use one pull-up resistor per stack.
Full	Connect all.	Connect using buffers.

Table 16 IRB Signal Details

Name	Pad Type	Buffer	Pull-up	Connection Type
100 Mbps IRB Signals				
IR100DAT<4:0>	Digital	Yes	No	Full
IR100CLK	Digital	Yes	1K	Full
IR100DV	Digital, Open Drain	Yes	300Ω	Full
IR100CFS	Analog	No	215Ω, 1%	Local
IR100CFSBP	Analog	No	91Ω, 1%	Stack
IR100COL	Digital	No	No	Local
IR100SNGL	Digital	No	No	Local
IR100DEN	Digital, Open Drain	N/A ¹	330Ω	Local
10 Mbps IRB Signals				
IR10DAT	Digital, Open Drain	Yes	330Ω	Full
IR10CLK	Digital	Yes	No	Full
IR10ENA	Digital, Open Drain	Yes	330Ω	Full
IR10CFS	Analog	No	215Ω, 1%	Local
IR10CFSBP	Analog	No	330Ω, 1%	Stack
IR10COL	Digital	No	330Ω, 1%	Local
IR10COLBP	Digital	No	330Ω, 1%	Stack
IR10DEN	Digital, Open Drain	N/A ¹	330Ω	Local
1. Driver Enable signals are provided to control an external bidirectional transceiver.				

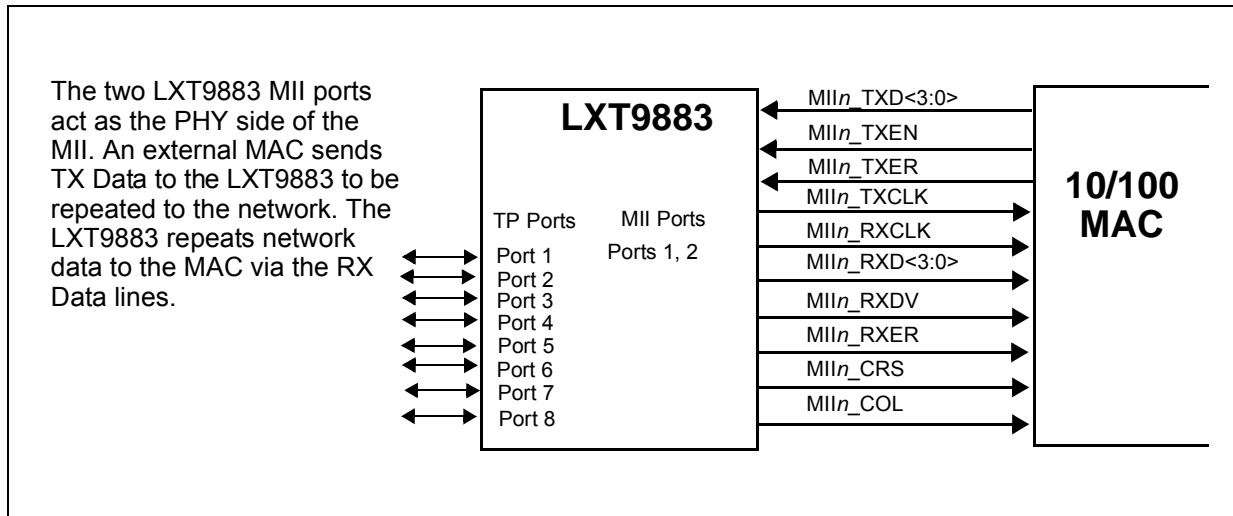
3.8 MII Port Operation

The LXT98x3 Repeater MII ports allow direct connection with a MAC. The MII ports can operate at either 10 Mbps or 100 Mbps. Speed control is provided via MII_n_SPD. For 100 Mbps operation, set MII_n_SPD = 1. For 10 Mbps operation, set MII_n_SPD = 0.

3.8.1 Preamble Handling

When operating at 100 Mbps, the LXT98x3 Repeater passes the full 56 bits of preamble through before sending the SFD. When operating at 10 Mbps, the LXT98x3 Repeater sends data across the MII starting with the 8-bit SFD (no preamble bits).

Figure 9 LXT9883 Repeater MII Operation



4.0 Application Information

4.1 General Design Guidelines

Following generally accepted design practices is essential to minimize noise levels on power and ground planes. Up to 50mV of noise is considered acceptable. 50mV to 80mV of noise is considered marginal. High-frequency switching noise can be reduced, and its effects can be eliminated, by following these simple guidelines throughout the design:

- Fill in unused areas of the signal planes with solid copper. Attach them with vias to a VCC or ground plane that is not located adjacent to the signal layer.
- Use ample bulk and decoupling capacitors throughout the design (a .01 μ F value is recommended for decoupling caps).
- Provide ample power and ground planes.
- Provide termination on all high-speed switching signals and clock lines.
- Provide impedance matching on long traces to prevent reflections.
- Route high-speed signals next to a continuous, unbroken ground plane.
- Filter and shield DC-DC converters, oscillators, etc.
- Do not route any digital signals between the LXT98x3 Repeater and the RJ-45 connectors at the edge of the board.
- Do not extend any circuit power and ground plane past the center of the magnetics or to the edge of the board. Use this area for chassis ground, or leave it void.

4.2 Power and Ground

4.2.1 Supply Filtering

Power supply ripple and digital switching noise on the VCC plane causes EMI and degrades line performance. Predicting a design's performance is difficult, although certain factors greatly increase the risks:

- Poorly-regulated or over-burdened power supplies.
- Wide data busses (>32-bits) running at a high clock rate.
- DC-to-DC converters.

Many of these issues can be improved by following good general design guidelines. In addition, Cortina recommends filtering between the power supply and the analog VCC pins of the LXT98x3 Repeater. Filtering has two benefits. First, it keeps digital switching noise out of the analog circuitry inside the LXT98x3 Repeater, which helps line performance. Second, if the VCC planes are laid out correctly, it keeps digital switching noise away from external connectors, reducing EMI.

The VCC plane should be divided into two sections. The digital section supplies power to the digital VCC pins and to the external components. The analog section supplies power to VCCR and VCCT pins of the LXT98x3 Repeater. The break between the two planes should run under the device. In designs with more than one LXT98x3 Repeater, use a single continuous analog VCC plane to supply them all.

The digital and analog VCC planes should be joined at one or more points by ferrite beads. The beads should produce at least a 100 Ω impedance at 100 MHz. The beads should be placed so current flows evenly. The maximum current rating of the beads

should be at least 150% of the current that is actually expected to flow through them. Each LXT98x3 Repeater draws a maximum of 1000 mA from the analog supply so beads rated at 1500 mA should be used. A bulk cap (2.2 -10 μ F) should be placed on each side of each ferrite bead to ground to stop switching noise from traveling through the ferrite.

In addition, a high-frequency bypass cap (.01 μ f) should be placed near each analog VCC pin to ground.

4.2.2 Ground Noise

The best approach to minimize ground noise is strict use of good general design guidelines and by filtering the VCC plane.

4.2.3 Power and Ground Plane Layout Considerations

The power and ground planes should be laid out carefully. The following guidelines are recommended:

- Follow the guidelines in the *Application Note 113 (LXT98x3 Repeater Design and Layout Guide)* for locating the split between the digital and analog VCC planes.
- Keep the digital VCC plane away from the TPOP/N and TPIP/N signals, magnetics, and RJ-45 connectors.
- Place the layers so the TPOP/N and TPIP/N signals are routed near or next to the ground plane. For EMI, it is more important to shield TPOP/N than TPIP/N.

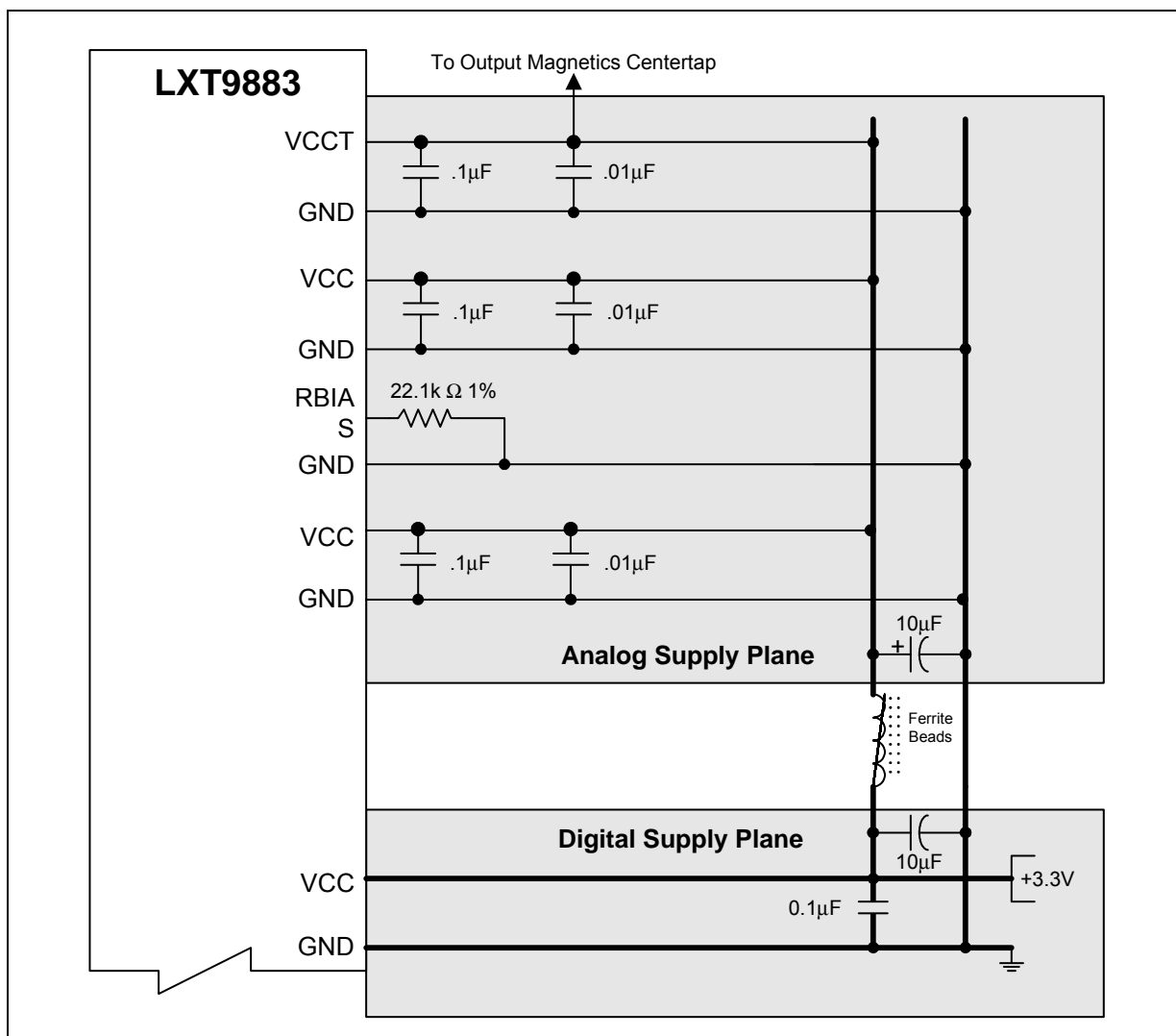
4.2.4 Chassis Ground

For ESD protection, create a separate chassis ground. For isolation, encircle the board and place a "moat" around the signal ground plane to separate signal ground from chassis ground. Chassis ground should extend from the RJ-45 connectors to the magnetics, and can be used to terminate unused signal pairs ('Bob Smith' termination). In single-point grounding applications, provide a single connection between chassis and circuit grounds with a 2kV isolation capacitor. In multi-point grounding schemes (chassis and circuit grounds joined at multiple points), provide 2kV isolation to the Bob Smith termination.

4.2.5 The RBIAS Pin

The LXT98x3 Repeater requires a 22.1 k Ω , 1% resistor directly connected between the RBIAS pin and ground. Place the RBIAS resistor as close to the RBIAS pin as possible. Run an etch directly from the pin to the resistor, sink the other side of the resistor, and surround the RBIAS trace with a filtered ground. *Do not run high-speed signals next to RBIAS.*

Figure 10 Power and Ground Connections



4.2.6 MII Terminations

The LXT98x3 Repeater MIIs have high output impedance ($250\text{-}350\Omega$). To minimize reflections, serial termination resistors are recommended on all MII signals, especially with designs with long traces (>3 inches). Place the resistor as close to the device as possible. Use a software trace termination package to select an optimal resistance value for the specific trace. Proper value = nominal trace impedance minus 13Ω . If a software package cannot be used and nominal trace impedance is not known, use 55Ω .

4.2.7 Twisted-Pair Interface

The LXT98x3 Repeater transmitter uses standard 1:1 magnetics for both receive and transmit. Nonetheless, system designers should take precautions to minimize parasitic shunt capacitance and meet return loss specifications. These steps include:

- Place magnetics as close as possible to the LXT98x3 Repeater.
- Keep transmit pair traces short.
- Do not route transmit pair adjacent to a ground plane. Eliminate planes under the transmit traces completely. Otherwise, keep planes 3-4 layers away.
- Improve EMI performance by filtering the output center tap supply. A single ferrite bead may be used in the center tap supply to all ports. All ports draw a combined total of ≥ 1000 mA, so the bead should be rated at ≥ 1500 mA.
- Place the 270pF 5% capacitors at TPIP and TPIN to improve the signal-to-noise immunity at the receiver.

In addition, follow all the standard guidelines for a twisted-pair interface:

- Route the signal pairs differentially, close together. Allow nothing to come between them.
- Keep distances as short as possible; both traces should have the same length.
- Avoid vias and layer changes.
- Keep the transmit and receive pairs apart to avoid cross-talk.
- To provide maximum isolation, place entire receive termination network on one side and transmit on the other side of the PCB.
- Bypass common-mode noise to ground on the in-board side of the magnetics using 0.01 μ F capacitors.
- Keep termination circuits grouped closely together and on the same side of the board.
- Always put termination circuits close to the source end of any circuit.

4.2.7.1 Magnetics Information

The LXT98x3 Repeater requires a 1:1 ratio for the receive transformers and a 1:1 ratio for the transmit transformers. The transformer isolation voltage should be rated at 2kV to protect the circuitry from static voltages across the connectors and cables. Refer to [Table 17](#) for magnetics specifications.

Table 17 LXT98x3 Repeater Magnetics Specifications

Parameter	Min	Nom	Max	Units	Test Condition
Rx turns ratio	–	1 : 1	–	–	
Tx turns ratio	–	1 : 1	–	–	
Insertion loss	0.0	–	1.1	dB	80 MHz
Primary inductance	350	–	–	μ H	
Transformer isolation	–	2	–	kV	
Differential to common mode rejection	-40	–	–	dB	.1 to 60 MHz
	-35	–	–	dB	60 to 100 MHz
Return Loss - standard	-16	–	–	dB	30 MHz
	-10	–	–	dB	80 MHz

4.2.8 Clock

A stable, external 25MHz reference clock source (TTL) is required to the CLK25 pin. The reference clock is used to generate transmit signals and recover receive signals. A crystal-based clock is recommended over a derived clock (i.e., PLL-based) to minimize transmit jitter. Refer to [Table 18](#) for a list of recommended oscillators and to [Table 21](#) on [page 45](#) for clock timing requirements.

Table 18 Oscillator Manufacturers

Manufacturer	Part Number	Frequency
CTS*	MXO45 / 45LV	25 MHz
Epson America*	SG-636 Series	25 MHz

Figure 11 Typical Twisted-Pair Port Interface and Power Supply Filtering

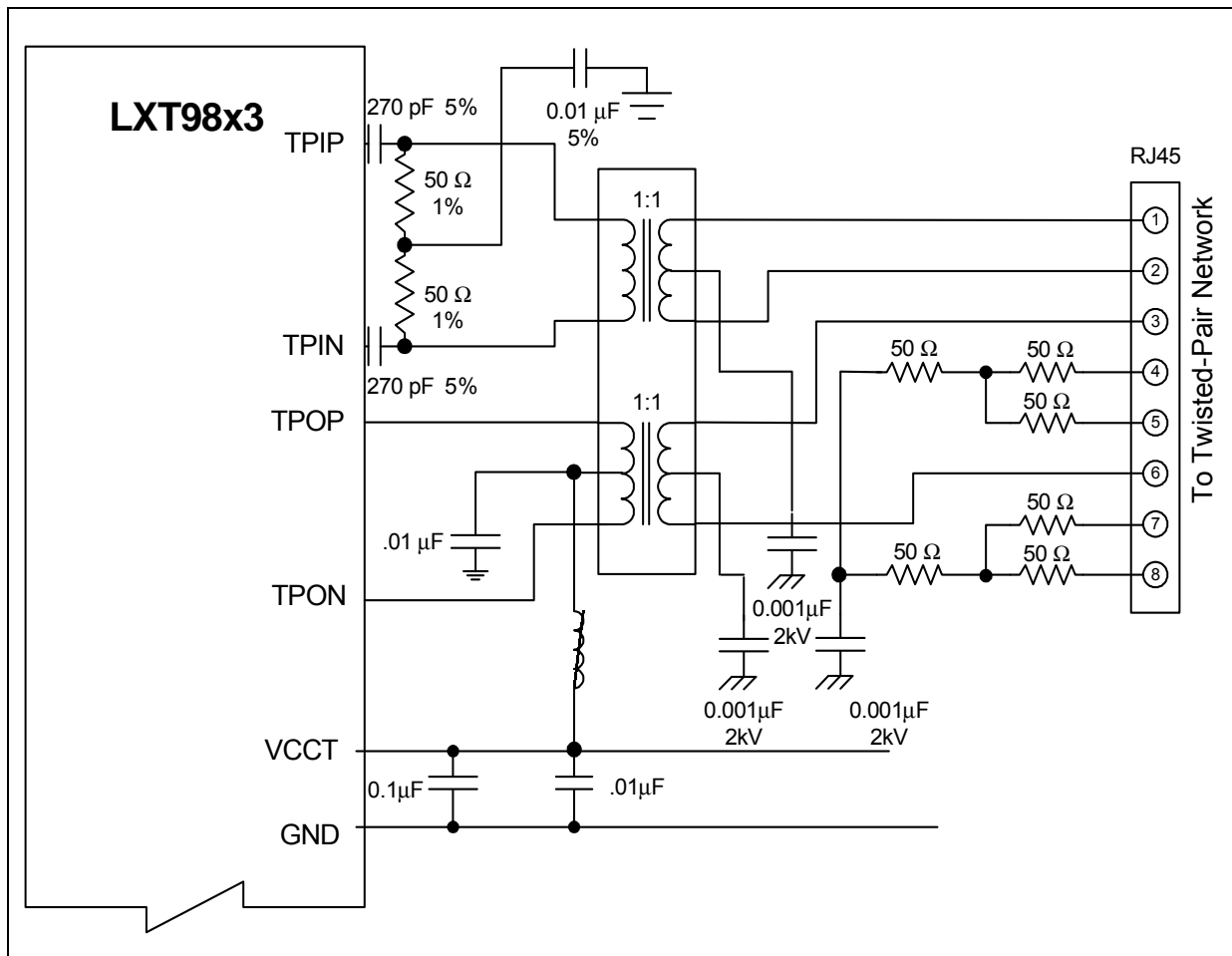
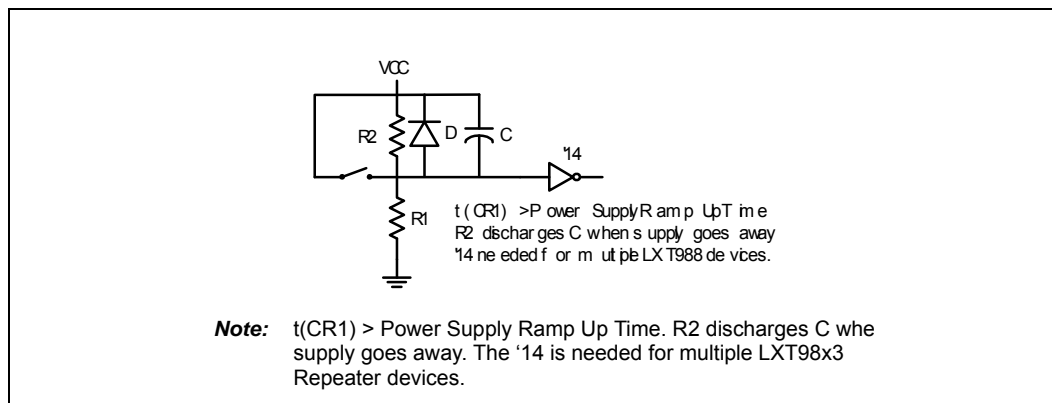


Figure 12 Typical Reset Circuit



4.2.9 LED Circuits

4.2.9.1 Direct Drive LEDs

Each Direct Drive LED has a corresponding open-drain pin. The LEDs are connected, via a current limiting resistor, to a positive voltage rail. The LEDs are turned on when the output pin drives Low. The open-drain LED pins are 5V tolerant, allowing use of either a 3.3V or 5V rail. A 5V rail eases LED component selection by allowing more common, high forward voltage LEDs to be used. Refer to [Figure 13](#) for a circuit illustration.

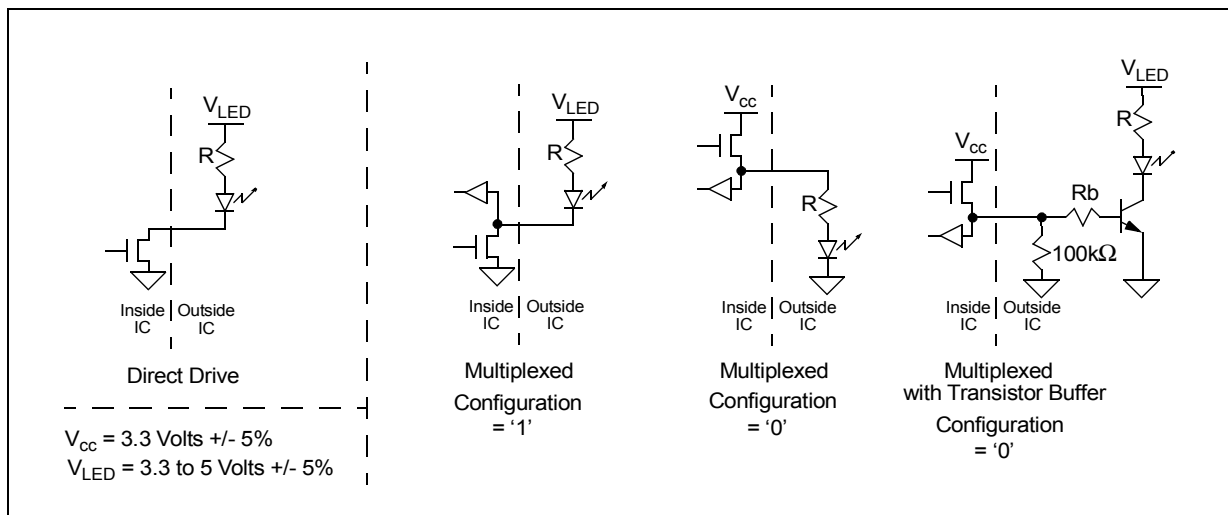
4.2.9.2 LED Pins Multiplexed with Configuration Inputs

Some static configuration inputs are multiplexed with LED pins to reduce the LXT98x3 Repeater pin count. These LED pins are configured by current sinking (open-drain output) and sourcing (open-source output). If the LED pin sinks the LED current, the configuration value is '1'. If LED pin sources the current, the configuration value is a '0'. The LXT98x3 Repeater detects the configuration value following reset and then selects the appropriate output drive circuit (open drain or source). If the LED function of a multiplexed configuration pin is not used, tie the pin to Ground or Vcc via a 100–500kΩ resistor to set the configuration value. Multiple LED configuration pins can be tied off with a single resistor to set them all to the same value. Refer to [Figure 13](#) for a circuit illustration.

For configuration values of '1', a 3.3V or a 5V rail can be used to drive the LEDs (to ease LED selection as with Direct Drive LEDs).

For configuration values of '0', external buffering is used when 5V LED driving is desired. (This buffering could be as simple as a single transistor.) As an alternative, use the copies of the multiplexed LED data found on the LED serial interface. 5V LED driving is achieved. Also, if a 5V tolerant serial-to-parallel device is used for the LED serial interface, 5V LED driving is achieved (see [Section 4.2.9.3, Serial LEDs, on page 40](#)).

Figure 13 LED Circuits - Direct Drive & Multiplexed Configuration Inputs



4.2.9.3 Serial LEDs

The LXT98x3 Repeater provides a serial interface to support additional LED options. Standard shift registers, either 74X595s (8-bit Serial-to-Parallel with Output Registers) or 74X164s (8-bit S/P without registers) can be used to drive these additional LEDs. Collision10/100 and Activity10/100 status indications are provided on multiplexed configuration pins and duplicated on the serial port.

The LED serial interface consists of three outputs: clock (LEDCLK), parallel latch clock (LEDLAT), and output data (LEDDAT). The parallel latch clock is used only with the 74X595 implementation. Refer to Figure 14 for an illustration of the LED serial interface circuit.

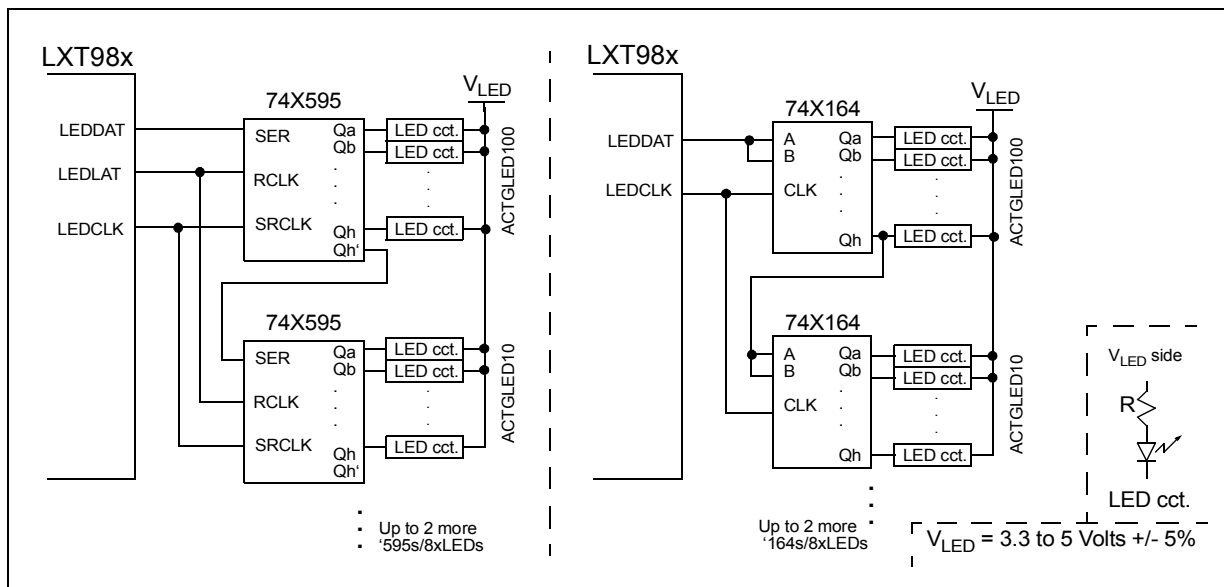
Potentially, 30 LEDs can be driven by the LED serial interface via 4 S/P devices. The S/P serial output is connected to the serial input of the first serial input device. To expand the chain, connect the last serial output to serial input of next serial interface device.

Serial LED data is output in the anticipated priority order, from least likely to most likely to be used:

- Unused '595/'164 parallel outputs
- MII Ports - LED1, 2, 3
- Miscellaneous LEDs (Repeat of Collision10/100, Repeat of Activity10/100, Global Fault, RPS Fault)
- ACTGLED10
- ACTGLED100

This allows the user to leave off devices in the serial-to-parallel chain if the LEDs associated with that condition aren't desired. Refer to Figure 6 on page 24 which illustrates the LED serial interface port signalling and Table 8 on page 24 which documents the Serial LED Stream.

Figure 14 Serial LED Circuit



4.3 Inter-Repeater Backplane Compatibility

The Inter-repeater Backplane (IRB) comprises two parts:

- Local—the backplane between cascaded devices on the same board.
- Stack—the backplane between multiple boards.

Each of these backplanes consists of both analog and digital signals.

4.3.1 Local Backplane—3.3V Only

The LXT98x3 Repeater local backplane operates at 3.3V only. LXT98x and LXT91x devices operate at 5V. LXT98x3 Repeater devices are, therefore, not cascadable with LXT98x and LXT91x devices.

Note: Do not mix LXT98x3 Repeater with either LXT98x or LXT91x devices on the local backplanes.

4.3.2 Stack Backplane—3.3V or 5V

The LXT98x3 Repeater stack backplanes can be configured to be either 3.3V or 5V. COMP_SEL (Pin 39), a special input pin, selects between the two voltage modes, depending on whether 3.3V or 5V is applied.

4.3.2.1 3.3V-Only Stacks

Apply 3.3V to COMP_SEL, $\overline{\text{IR100CFSBP}}$, $\overline{\text{IR10CFSBP}}$, and $\overline{\text{IR10COLBP}}$ for LXT98x3 Repeater backplane operation

4.3.2.2 For 5V Backwards Stackability

Apply 5V to COMP_SEL, $\overline{\text{IR100CFSBP}}$, $\overline{\text{IR10CFSBP}}$, and $\overline{\text{IR10COLBP}}$ for LXT98x and LXT91x backplane operation.

Note: With either mode (3.3V or 5V), COMP_SEL draws less than 3 mA.

1. The external pull-up resistor values remain the same, regardless of 3.3V or 5V backplane operation.
2. The recommended digital signal external buffer has been changed to 74LVT245 for the LXT98x3 Repeater.

4.3.2.3 3.3V and 5.0V Stacking Boards Cannot Be Mixed

4.3.2.3.1 3.3V Operation

Boards designed for 3.3V backplane operation should only be stacked with other 3.3V boards. Existing LXT98x or LXT91x based designs cannot operate in 3.3V.

4.3.2.3.2 Incompatible Stacking Configurations

The following stacking configurations are incompatible:

- A LXT98x3 Repeater-based board configured for 3.3V backplane operation and LXT98x or LXT91x based boards (5V only).
- A LXT98x3 Repeater-based board configured for 3.3V backplane operation and a LXT98x3 Repeater-based board configured for 5V backplane operation.

Note: Stacking boards designed for 3.3V backplane operation with boards designed for 5V backplane operation causes network errors.

4.3.2.3.3 5V Operation

Boards designed for 5V backplane operation should only be stacked with other 5V boards:

- LXT98x or LXT91x-based designs.
- LXT98x3 Repeater designs configured for 5V backplane operation.

The configuration input must be connected to 5V for compatibility with LXT98x or LXT91x-based designs. The 5V can be supplied from the stacking cable, or a 5V source must exist within the board itself.

Caution: Stacking boards designed for 5V backplane operation with boards designed for 3.3V backplane operation causes network errors.

Figure 15 100M Backplane Connection between LXT98x and LXT98x3 Repeater

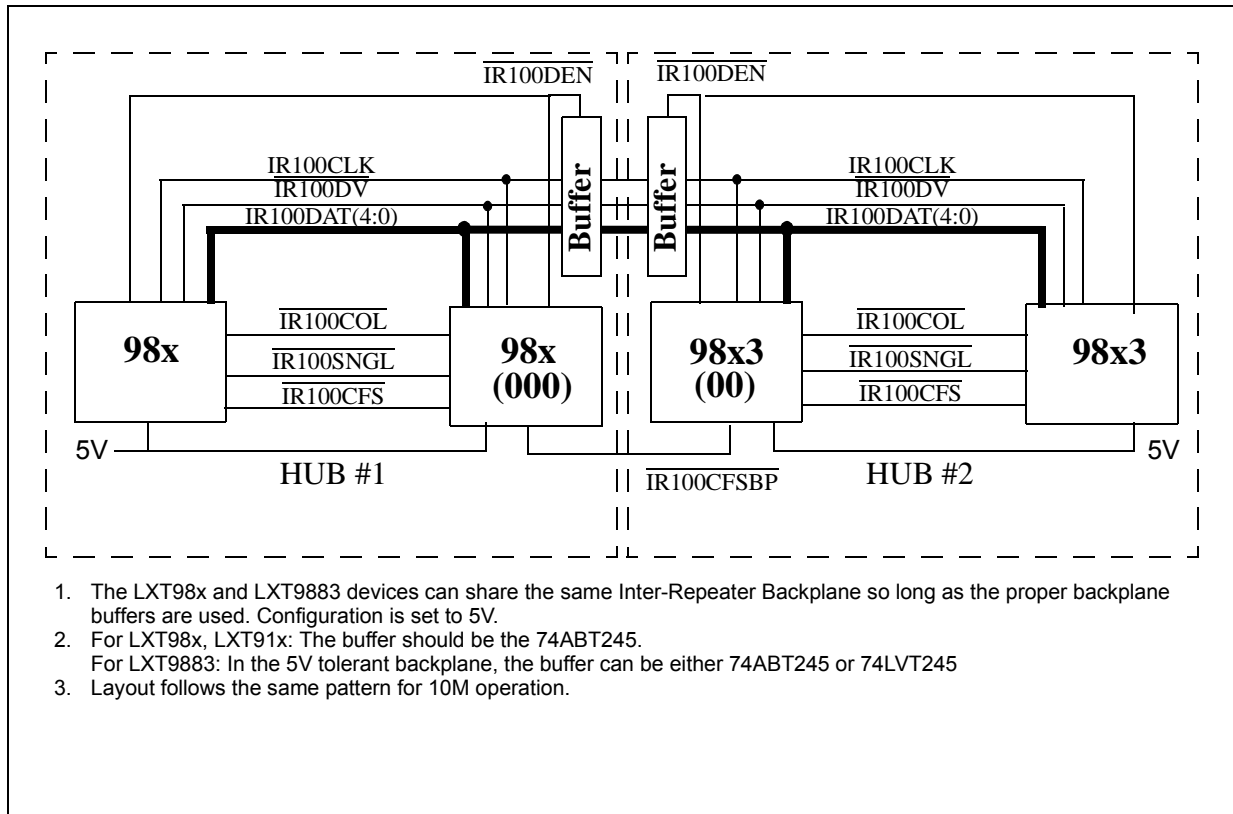


Figure 16 Typical 100 Mbps IRB Implementation

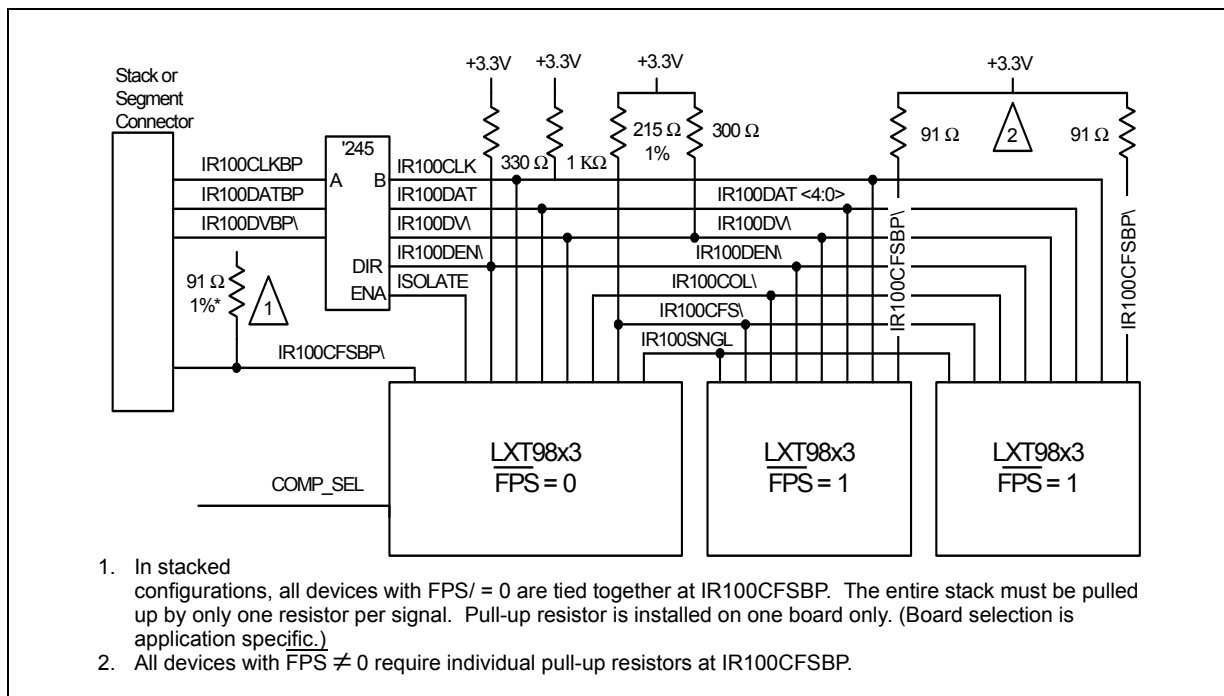
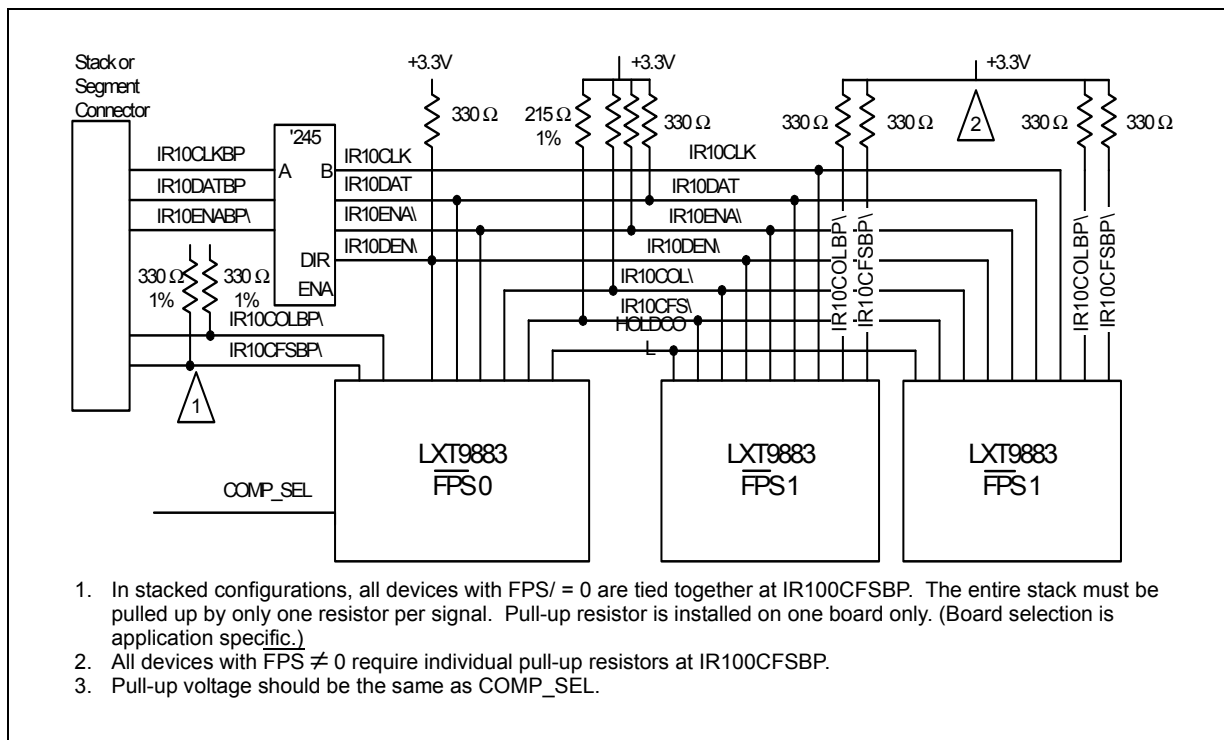


Figure 17 Typical 10 Mbps IRB Implementation



5.0 Test Specifications

Note: Table 19 through Table 34 and Figure 18 through Figure 25 represent the target specifications of the LXT98x3 Repeater and are subject to change. Final values will be guaranteed by test except, where noted, by design. The minimum and maximum values listed in Table 21 through Table 34 will be guaranteed over the recommended operating conditions specified in Table 20.

Table 19 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units
Supply voltage	VCC	-0.3	4.0	V
Storage temperature	TST	-65	+150	°C

Caution: Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 20 Operating Conditions

Parameter	Sym	Min	Typ ¹	Max	Units	
Recommended supply voltage	VCC	3.15	3.3	3.45	V	
	VCCR	3.15	3.3	3.45	V	
	VCCT	3.15	3.3	3.45	V	
Recommended operating temperature	Ambient	TOPA	0	–	70	°C
	Case	TOPC	0	–	115	°C
Power consumption	8 ports active	PC	–	–	3.03	W
	6 ports active	PC	–	–	2.50	W

1. Typical values are at 25° C and are for design aid only; they are not guaranteed and not subject to production testing.

Table 21 Input System Clock¹ Requirements

Parameter ²	Symbol	Min	Typ ³	Max	Units	Test Conditions
Frequency	–	–	25	–	MHz	–
Frequency Tolerance	–	–	–	±100	PPM	–
Duty Cycle	–	40	–	60	%	–

1. The system clock is CLK25 (Pin 54).
 2. These requirements apply to the external clock supplied to the LXT98x3 Repeater, not to LXT98x3 Repeater test specifications.
 3. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.

Table 22 I/O Electrical Characteristics

Parameter	Sym	Min	Typ ¹	Max	Units	Test Conditions
Input Low voltage	VIL	–	–	0.8	V	TTL inputs
		–	–	30	% V _{CC}	CMOS inputs ²
		–	–	1.0		Schmitt triggers ³
Input High voltage	VIH	2.0	–	–	V	TTL inputs
		70	–	–	% V _{CC}	CMOS inputs ²
		V _{CC} - 1.0	–	–	V	Schmitt triggers ³
Hysteresis voltage	–	1.0	–	–	V	Schmitt triggers ³
Output Low voltage	VOL	–	–	0.4	V	IOL = 1.6 mA
Output Low voltage (LED)	VOLL	–	–	1.0	V	IOLL = 10 mA
Output High voltage	VOH	2.2	–	–	V	IOH = 40 μA
Input Low current	IIL	-100	–	–	μA	–
Input High current	IIH	–	–	100	μA	–
Output rise / fall time	TRF	–	3	10	ns	C _L = 15 pF

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Does not apply to IRB pins. Refer to Table 23 and Table 24 for IRB I/O characteristics.
 3. Applies to RESET, CLK25, IR100SNGL, IR100COL, IR100DV, IR100DAT_n, IR100CLK, and IR100CLK pins.

Table 23 100 Mbps IRB Electrical Characteristics (Sheet 1 of 2)

Parameter	Symbol	Min	Typ ¹	Max	Units	Test Conditions
Output Low voltage	VOL	–	.3	.7	V	R _L = 330 Ω
Output rise or fall time	TRF	–	4	10	ns	C _L = 15 pF
Input High voltage	VIH	V _{CC} - 2.0	–	–	V	CMOS inputs
		V _{CC} - 1.0	–	–	V	IR100CLK (Schmitt trigger)
Input Low voltage	VIL	–	–	2.0	V	CMOS inputs
		–	–	1.0		IR100CLK (Schmitt trigger)
Hysteresis voltage	–	1.0	–	–	V	IR100CLK (Schmitt trigger)
3.3V Operation						
IR100CFS current	single drive	–	–	6.8	–	mA R _L = 215 Ω
	collision	–	–	13.5	–	mA R _L = 215 Ω
IR100CFSBP current	single drive	–	–	16.1	–	mA R _L = 91 Ω ²
	collision	–	–	31.8	–	mA R _L = 91 Ω ²

1. Typical values are at 25° C and are for design aid only; they are not guaranteed and not subject to production testing.
 2. 91Ω resistors provide greater noise immunity. Systems using 91Ω resistors are backwards stackable with systems using 100Ω resistors.

Table 23 100 Mbps IRB Electrical Characteristics (Sheet 2 of 2)

Parameter	Symbol	Min	Typ ¹	Max	Units	Test Conditions
$\overline{\text{IR100CFS/BP}}$ voltage	single drive	–	–	1.83	–	V –
	collision	–	–	0.4	–	V –
5.0V Operation						
$\overline{\text{IR100CFS}}$ current	single drive	–	–	N/A	–	mA RL = 215 Ω
	collision	–	–	N/A	–	mA RL = 215 Ω
$\overline{\text{IR100CFSBP}}$ current	single drive	–	–	24.2	–	mA RL = 91 Ω^2
	collision	–	–	42	–	mA RL = 91 Ω^2
$\overline{\text{IR100CFS/BP}}$ voltage	single drive	–	–	2.8	–	V –
	collision	–	–	0.6	–	V –
1. Typical values are at 25° C and are for design aid only; they are not guaranteed and not subject to production testing. 2. 91 Ω resistors provide greater noise immunity. Systems using 91 Ω resistors are backwards stackable with systems using 100 Ω resistors.						

Table 24 10 Mbps IRB Electrical Characteristics

Parameter	Symbol	Min	Typ ¹	Max	Units	Test Conditions
Output Low voltage	VOL	0	.1	.4	V	RL = 330 Ω
Output rise or fall time	TRF	–	4	10	ns	CL = 15 pF
Input High voltage	VIH	VCC - 2.0	–	–	V	CMOS inputs
		VCC - 2.0	–	–	V	IR10CLK (Schmitt trigger)
Input Low voltage	VIL	–	–	2.0	V	CMOS inputs
		–	–	1.0	V	IR10CLK (Schmitt trigger)
Hysteresis voltage	–	0.5	–	–	V	IR10CLK (Schmitt trigger)
3.3V Operation						
$\overline{\text{IR10CFS}}$ current	single drive	–	–	6.8	–	mA RL = 215 Ω
	collision	–	–	13.5	–	mA RL = 215 Ω
$\overline{\text{IR10CFSBP}}$ current	single drive	–	–	4.5	–	mA RL = 330 Ω
	collision	–	–	8.8	–	mA RL = 330 Ω
$\overline{\text{IR10CFS/BP}}$ voltage	single drive	–	1.3	1.83	2.4	V –
	collision	–	0.2	0.4	0.6	V –
5.0V Operation						
$\overline{\text{IR10CFS}}$ current	single drive	–	–	N/A	–	mA RL = 215 Ω
	collision	–	–	N/A	–	mA RL = 215 Ω
$\overline{\text{IR10CFSBP}}$ current	single drive	–	–	7.0	–	mA RL = 330 Ω
	collision	–	–	13.5	–	mA RL = 330 Ω
$\overline{\text{IR10CFS/BP}}$ voltage	single drive	–	1.9	2.8	3.2	V –
	collision	–	0.4	0.6	0.8	V –
1. Typical values are at 25° C and are for design aid only; they are not guaranteed and not subject to production testing.						

Table 25 100BASE-TX Transceiver Electrical Characteristics

Parameter	Symbol	Min	Typ ¹	Max	Units	Test Conditions
Peak differential output voltage (single ended)	V _P	0.95	1.0	1.05	V	Note 2
Signal amplitude symmetry	–	98	–	102	%	Note 2
Signal rise/fall time	Trf	3.0	–	5.0	ns	Note 2
Rise/fall time symmetry	Trfs	–	–	0.5	ns	Note 2
Duty cycle distortion	–	–	–	+/- 0.5	ns	Offset from 8 ns pulse width at 50% of pulse peak,
Overshoot	V _o	–	–	5	%	–

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Measured at line side of transformer, line replaced by 100Ω (±1%) resistor.

Table 26 10BASE-T Transceiver Electrical Characteristics

Parameter	Symbol	Min	Typ ¹	Max	Units	Test Conditions
Transmitter						
Peak differential output voltage	V _P	2.2	2.5	2.8	V	Measured at line side of transformer, line replaced by 100Ω (±.1%) resistor
Transmit timing jitter addition ²	–	8	–	24	ms	0 line length for internal MAU
Transmit timing jitter added by the MAU and PLS sections ^{2,3}	–	0	–	11	ns	After line model specified by IEEE 802.3 for 10BASE-T internal MAU
Receiver						
Receive input impedance	Z _{IN}	–	20	–	kΩ	Between TPIP/TPIN
Differential Squelch Threshold	V _{DS}	–	390	–	mV	5 MHz square wave input, 750 mVpp

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Parameter is guaranteed by design; not subject to production testing.
 3. IEEE 802.3 specifies maximum jitter additions at 1.5 ns for the AUJ cable, 0.5 ns from the encoder, and 3.5 ns from the MAU.

Figure 18 100 Mbps TP Port-to-Port Delay Timing

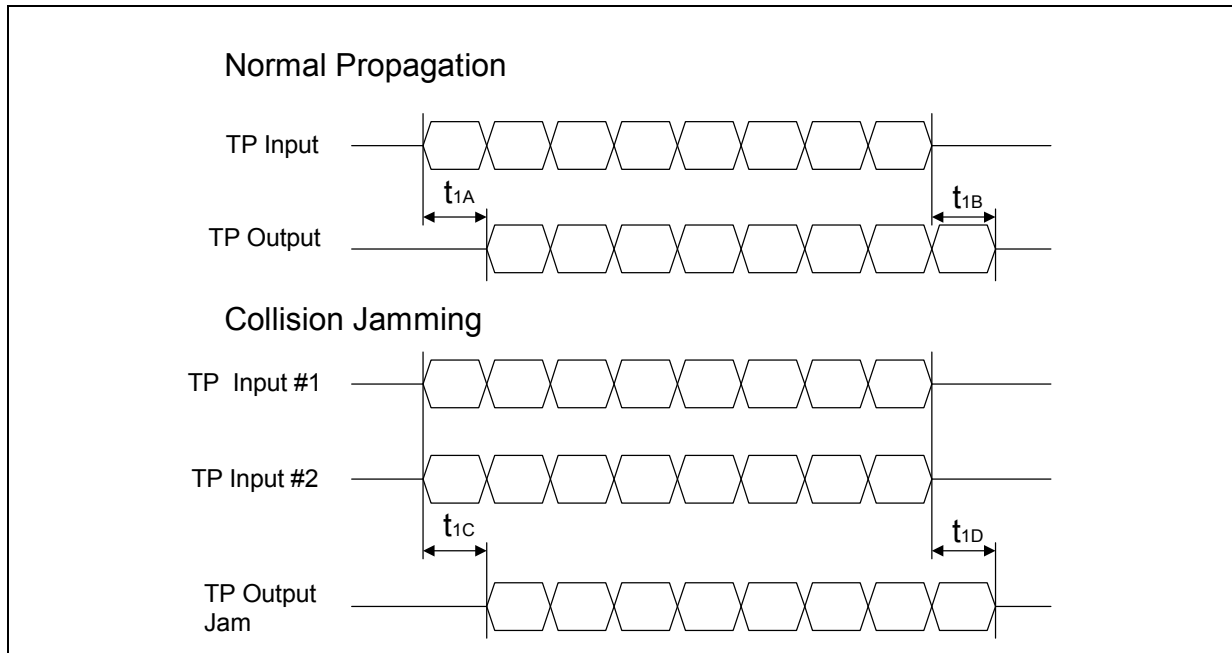


Table 27 100 Mbps TP Port-to-Port Delay Timing Parameters

Parameter	Symbol	Min	Typ ¹	Max	Units ²	Test Conditions
TPIP/N to TPOP/N, start of transmission	t _{1A}	–	–	46	BT	–
TPIP/N to TPOP/N, end of transmission	t _{1B}	–	–	46	BT	–
TPIP/N collision to TPOP/N, start of jam	t _{1C}	–	–	46	BT	–
TPIP/N idle to TPOP/N, end of jam	t _{1D}	–	–	46	BT	–

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 100BASE-T = 10⁻⁸ s or 10ns.

Figure 19 100BASE-TX MII-to-TP Port Timing

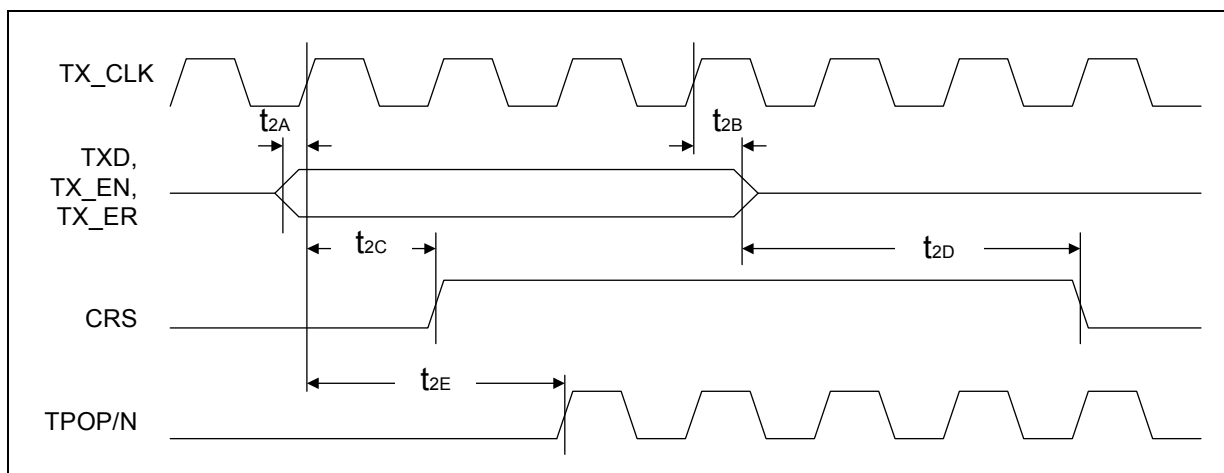


Table 28 100BASE-TX MII-to-TP Port Timing Parameters

Parameter	Sym	Min	Typ ¹	Max	Units ²	Test Condition
TXD, TX_EN, TX_ER Setup to TX_CLK High	t _{2A}	10	–	–	ns	–
TXD, TX_EN, TX_ER Hold from TX_CLK High	t _{2B}	5	–	–	ns	–
TX_EN sampled to CRS asserted	t _{2C}	0	–	4	BT	–
TX_EN sampled to CRS de-asserted	t _{2D}	0	–	16	BT	–
TX_EN sampled to TPOP/N active (Tx latency)	t _{2E}	–	–	46	BT	–

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 100BASE-T = 10⁻⁸ s or 10ns.

Figure 20 100BASE-TX TP-to-MII Timing

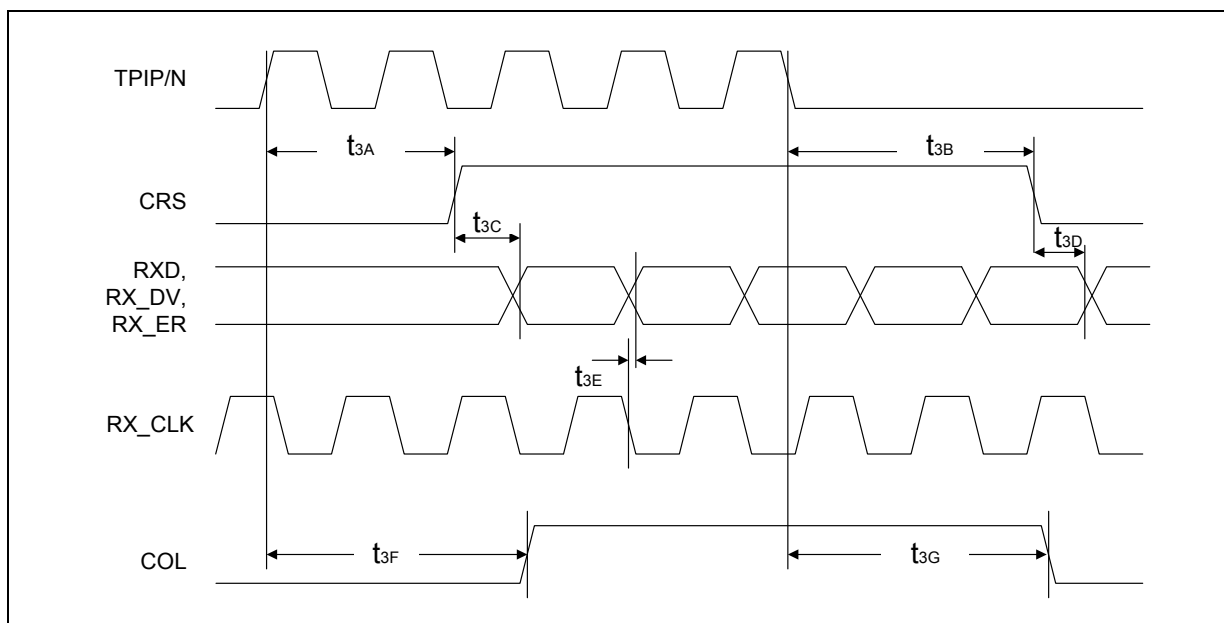


Table 29 100BASE-TX TP-to-MII Timing Parameters

Parameter	Sym	Min	Typ ¹	Max	Units ²	Test Conditions
TPIP/N in to CRS asserted	t _{3A}	–	–	46	BT	–
TPIP/N quiet to CRS de-asserted	t _{3B}	–	–	46	BT	–
CRS asserted to RXD, RX_DV, RX_ER	t _{3C}	1	–	4	BT	–
CRS de-asserted to RXD, RX_DV, RX_ER de-asserted	t _{3D}	–	–	3	BT	–
RX_CLK falling edge to RXD, RX_DV, RX_ER valid	t _{3E}	–	–	10	ns	–
TPIP/N in to COL asserted	t _{3F}	–	–	46	BT	–
TPIP/N quiet to COL de-asserted	t _{3G}	–	–	46	BT	–

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 100BASE-T = 10⁻⁸ s or 10ns.

Figure 21 10BASE-T MII-to-TP Timing

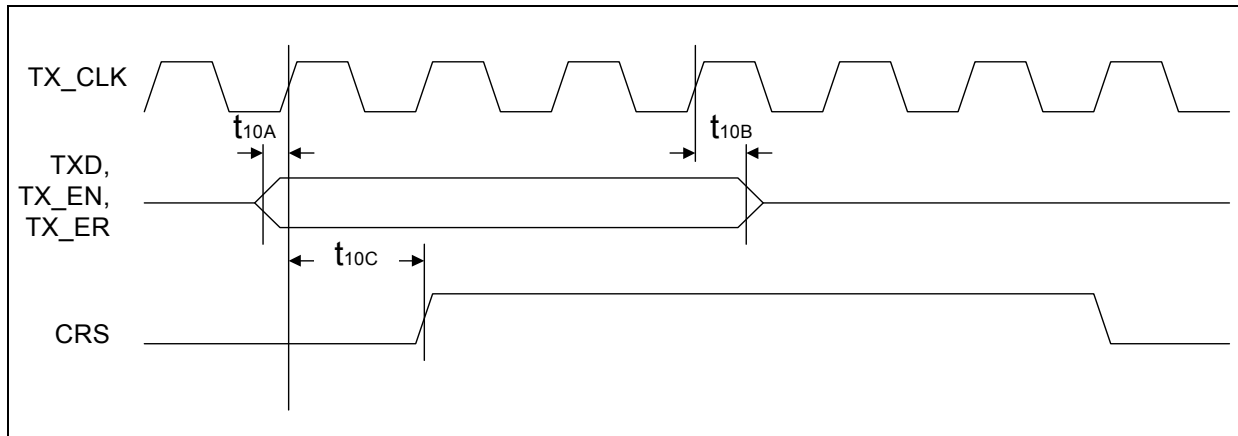


Table 30 10BASE-T MII-to-TP Timing Parameters

Parameter	Sym	Min	Typ ¹	Max	Units ²	Test Conditions
TXD, TX_EN, TX_ER Setup to TX_CLK High	t _{10A}	10	–	–	ns	–
TXD, TX_EN, TX_ER Hold from TX_CLK High	t _{10B}	5	–	–	ns	–
TX_EN sampled to CRS asserted	t _{10C}	0	.9	2	BT	–

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 10BASE-T = 10⁻⁷ s or 100ns.

Figure 22 10BASE-T TP-to-MII Port Timing

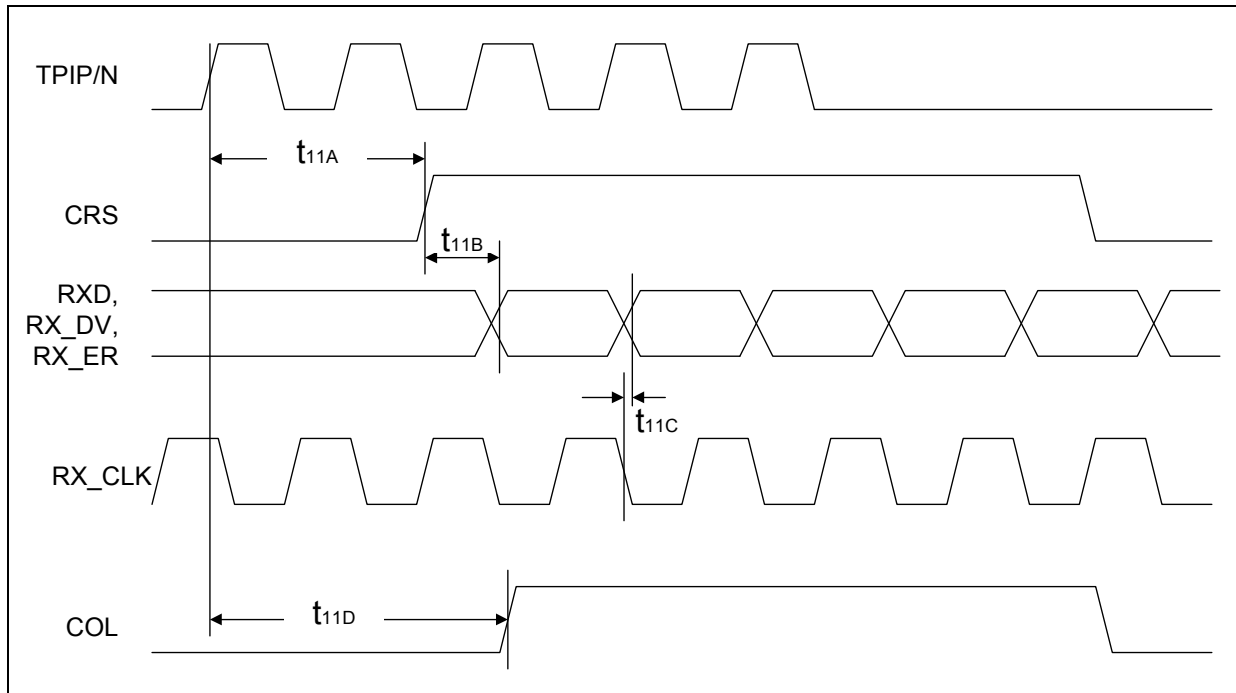


Table 31 10BASE-T TP-to-MII Port Timing Parameters

Parameter	Sym	Min	Typ ¹	Max	Units ²	Test Conditions
TPIP/N in to CRS asserted	t _{11A}	5	6.6	8	BT	–
CRS asserted to RXD, RX_DV, RX_ER	t _{11B}	70	76	84	BT	–
RX_CLK falling edge to RXD, RX_DV, RX_ER valid	t _{11C}	–	–	10	ns	–
TPIP/N in to COL asserted	t _{11D}	6	7.4	9	BT	–

1. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
 2. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 10BASE-T = 10⁻⁷s or 100ns.

Figure 23 100 Mbps TP-to-IRB Timing

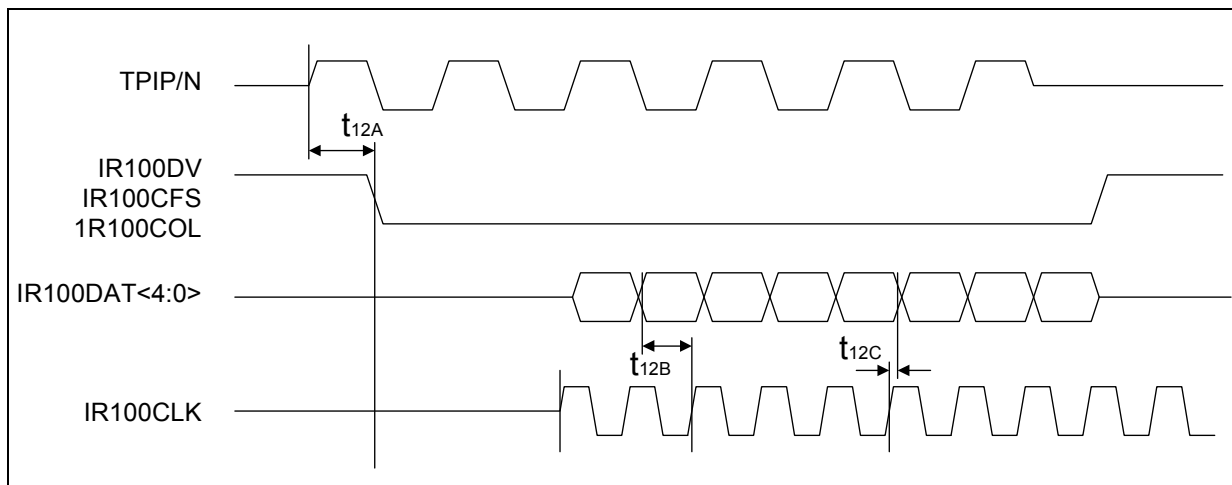


Table 32 100 Mbps TP-to-IRB Timing Parameters¹

Parameter	Symbol	Min	Typ ²	Max	Units ³	Test Conditions
TPIP/N to $\overline{\text{IR100DV}}$ Low	t_{12A}	18	24	30	BT	–
IR100DAT to IR100CLK setup time.	t_{12B}	–	10	–	ns	–
IR100DAT to IR100CLK hold time.	t_{12C}	–	0	–	ns	–

1. This table contains propagation delays from the TP ports to the IRB for normal repeater operation. All values in this table are output timings.
 2. Typical figures are at 25 C and are for design aid only; not guaranteed and not subject to production testing.
 3. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 100BASE-T = 10^{-8} s or 10ns.

Figure 24 10 Mbps TP-to-IRB Timing

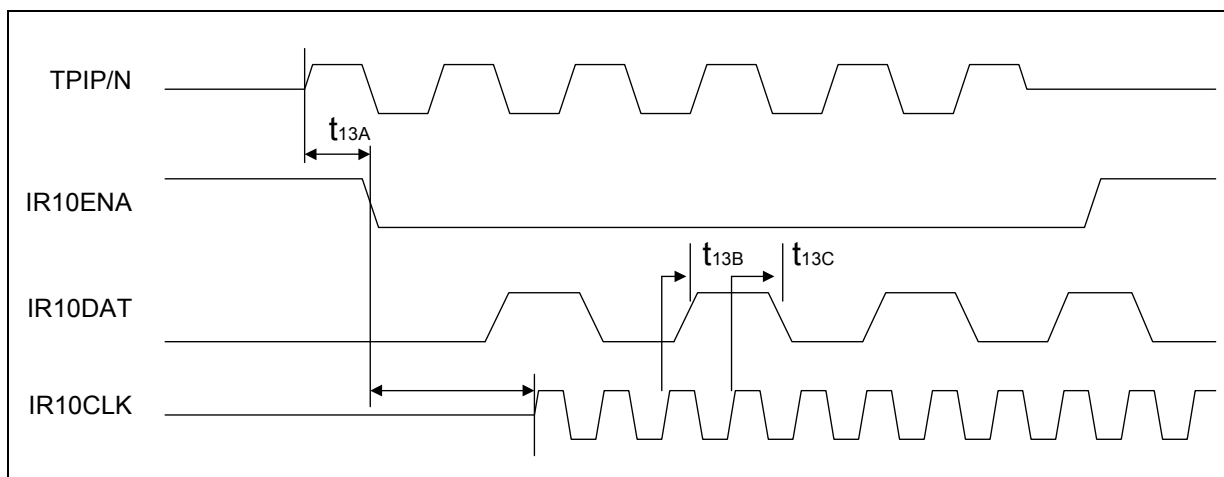


Table 33 10 Mbps TP-to-IRB Timing Parameters¹

Parameter ²	Symbol	Min	Typ ³	Max	Units ⁴	Test Conditions
TPIP/N to $\overline{\text{IR10ENA}}$ Low	t_{13A}	3	5.1	7	BT	–
IR10CLK rising edge to IR10DAT rising edge.	t_{13B}	25	-	55	ns	330 Ω pull-up, 150pF load on IR10DAT. 1 k Ω pull-up, 150pF load on IRCLK.
IR10CLK rising edge to IR10DAT falling edge.	t_{13C}	5	-	25	ns	

1. This table contains propagation delays from the TP ports to the IRB for normal repeater operation. All values in this table are output timings.
2. There is a delay of approximately 13 to 16 bit times between the assertion of $\overline{\text{IR10ENA}}$ and the assertion of IR10CLK and IR10DAT. This delay does not affect repeater operation because downstream devices begin generating preamble as soon as $\overline{\text{IR10ENA}}$ is asserted.
3. Typical values are at 25 °C and are for design aid only; not guaranteed and not subject to production testing.
4. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 10BASE-T = 10⁻⁷ s or 100ns.

Figure 25 10 Mbps IRB-to-TP Port Timing

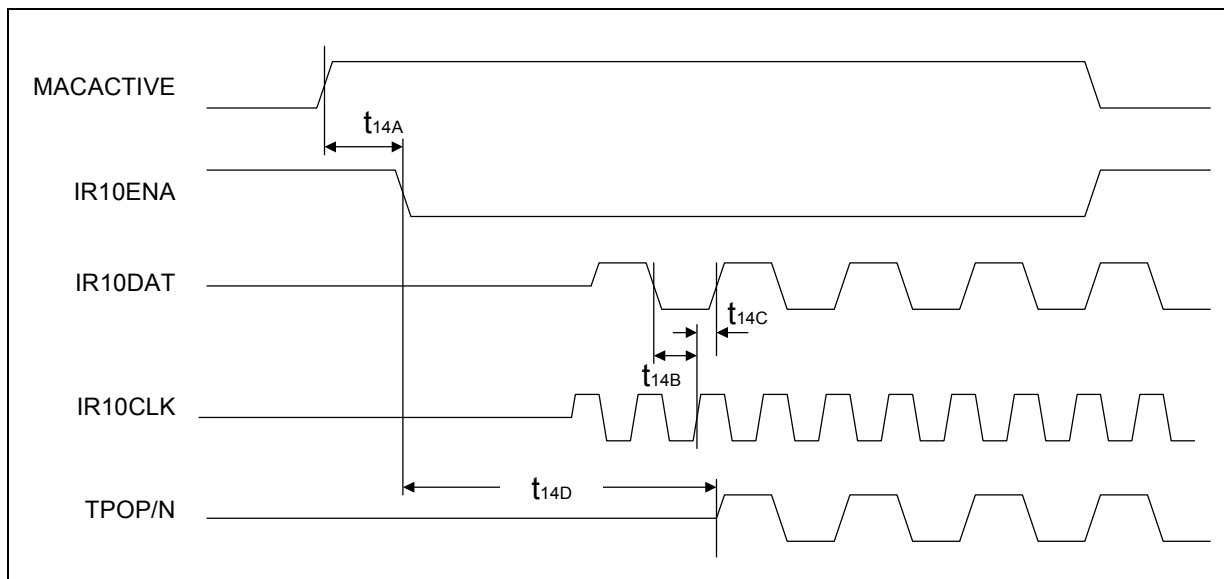


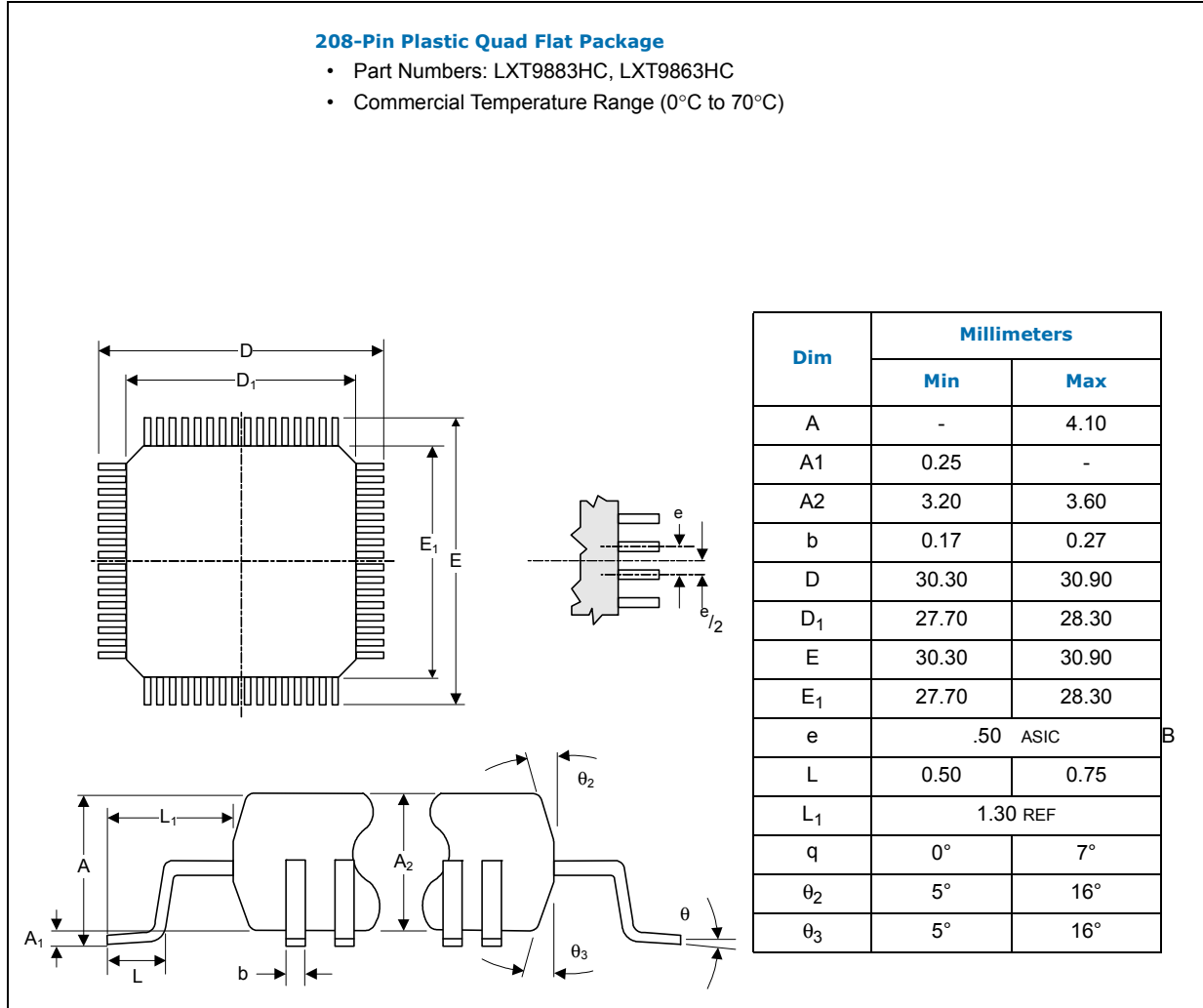
Table 34 10 Mbps IRB-to TP Port Timing Parameters

Parameter	Symbol	Min	Typ ¹	Max	Units ²	Test Conditions
MACACTIVE to $\overline{\text{IR10ENA}}$ assertion delay ³	t_{14A}	–	100	–	ns	MACACTIVE High to $\overline{\text{IR10ENA}}$ Low. ⁴
IR10DAT (input) to IR10CLK setup time	t_{14B}	–	20	–	ns	IR10DAT valid to IR10CLK rising edge. ⁴
IR10CLK to IR10DAT (input) hold time	t_{14C}	–	0	–	ns	IR10CLK rising edge to IR10DAT change. ⁴
$\overline{\text{IR10ENA}}$ asserted to TPOP/N active	t_{14D}	5	5.1	6	BT	–

1. Typical values are at 25° C and are for design aid only; they are not guaranteed and not subject to production testing.
 2. Bit Time (BT) is the duration of one bit as transferred to/from the MAC and is the reciprocal of bit rate. BT for 10BASE-T = 10⁻⁷ s or 100ns.
 3. External devices should allow at least one 10 MHz clock cycle (10 ns) between assertion of MACACTIVE and $\overline{\text{IR10ENA}}$.
 4. Input.

6.0 Mechanical Specifications

Figure 26 LXT98x3 Package Specifications





For additional product and ordering information:

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